

New production technologies for printed electronics

Thomas Kolbusch, Vice President

Summary

Introduction

Our markets

Equipment

R&D

The printed
electronics
market

Bridging
the gap

Technologies
& Processes

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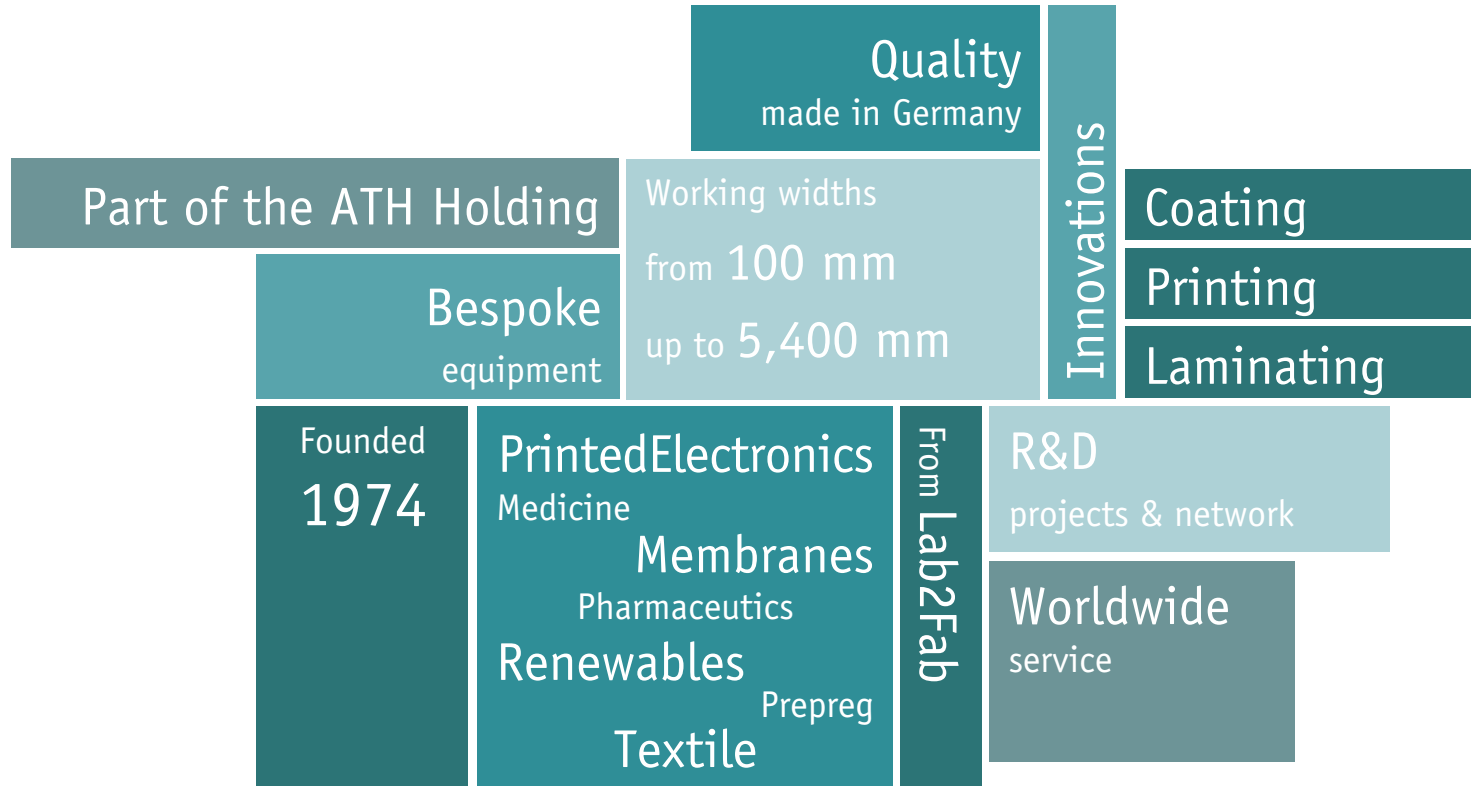
The printed
electronics
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Bridging
the gap

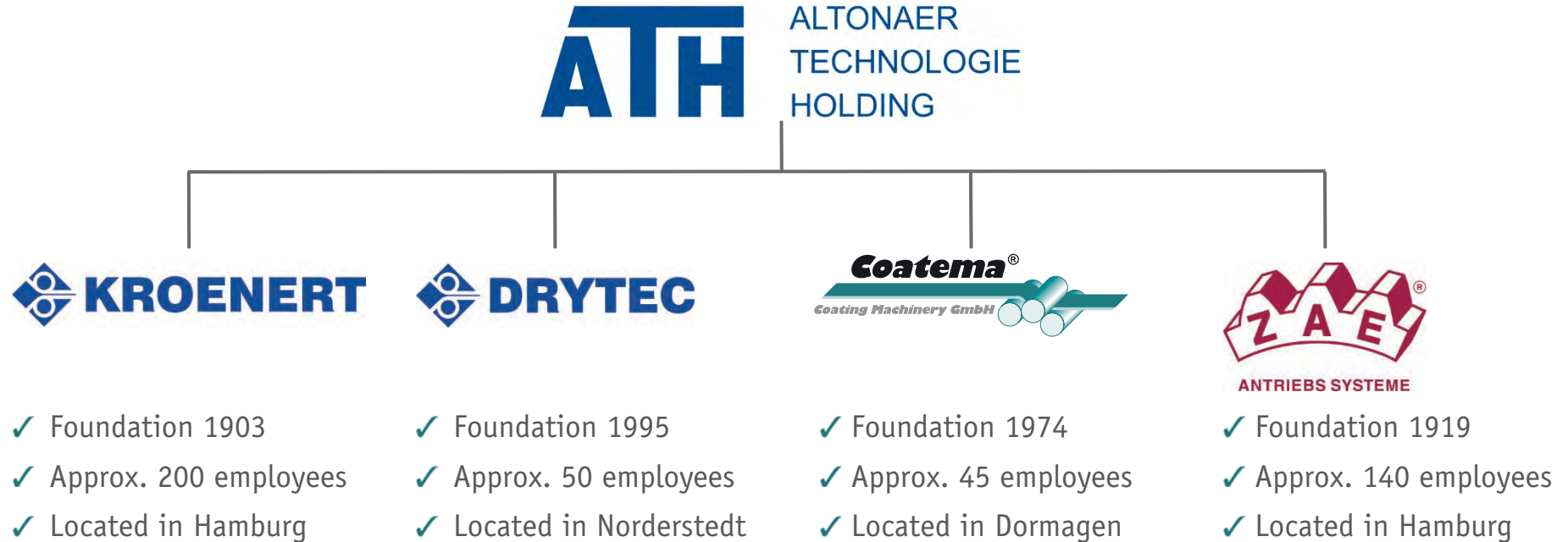
Technologies
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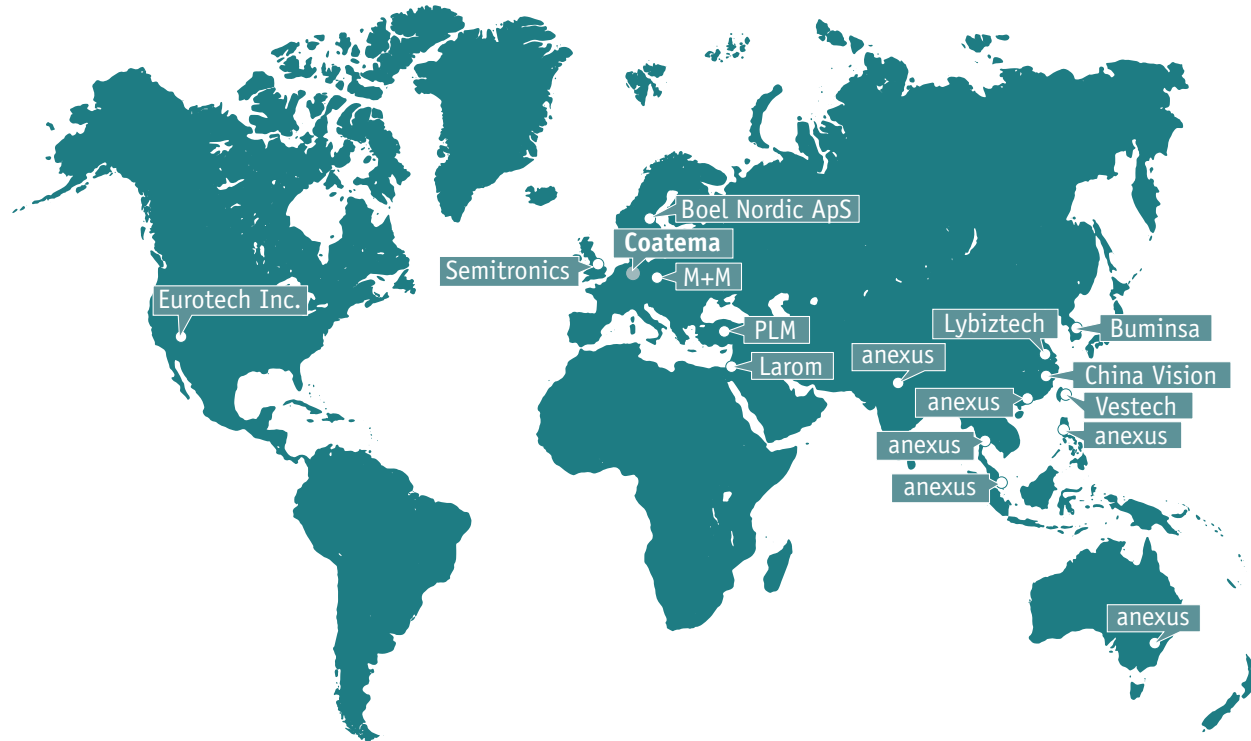
Overview



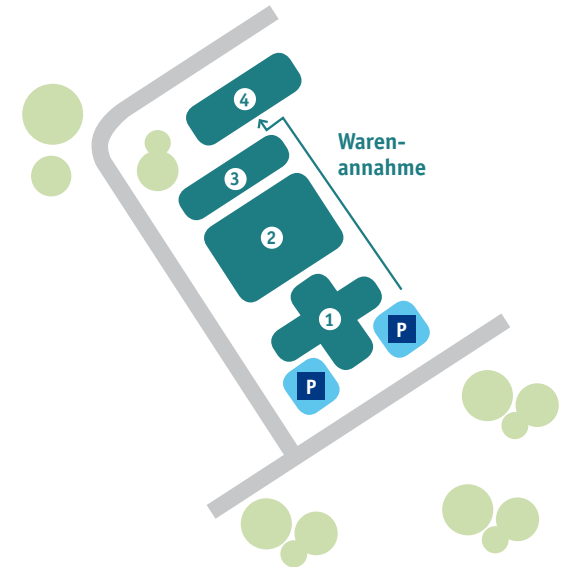
Group of Companies



Represented Worldwide



Headquarter in Dormagen



- 1 Hauptverwaltung
- 2 Technikum
- 3 Endmontage
- 4 Lager / Warenannahme
- P Besucherparkplätze

Milestones

1974

Foundation



2003

Patent "Doublesided coating system" and "Indirect Knife system"



2006

New company site, expansion to 10.000qm



2007

Click&Coat registered as Trademark



2013

New corporate design



2000

First Coatema Symposium



2001

New company site with a centre for research and development



2007

Opening R&D housed in an area of 1,200 square meters



2011

IDTechEx award "Technical Development: Manufacturing Europe & USA"



2018

KROENERT and Coatema Under One Umbrella Company



Vision – From Lab2Fab



Lab



Pilot



Production

Coatema equipment platform strategy for Lab2Fab

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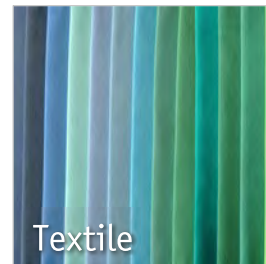
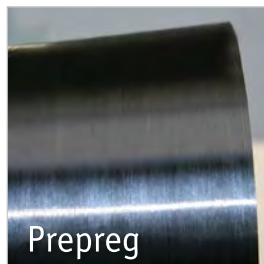
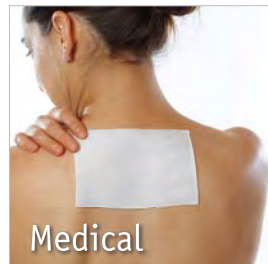
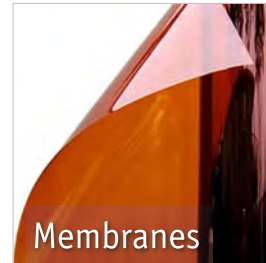
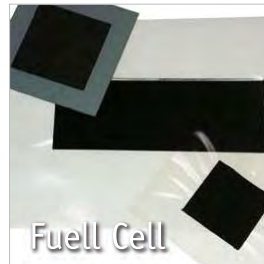
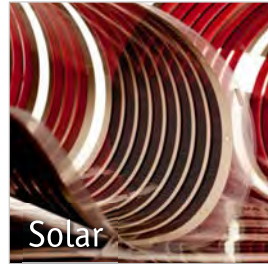
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Renewables



Markets:

✓ Battery



✓ Fuel Cell



✓ Solar



Printed Electronics



Markets:

- ✓ Conductive coatings
- ✓ Smart systems
- ✓ Displays
- ✓ RFID
- ✓ OLED
- ✓ OPV
- ✓ Electronics



Membranes



Markets:

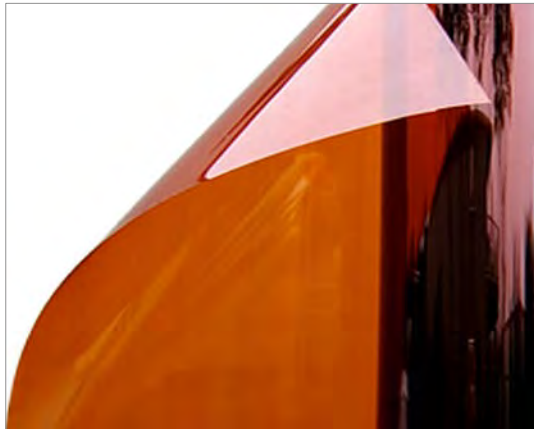
✓ Reverse Osmosis

✓ Water purification

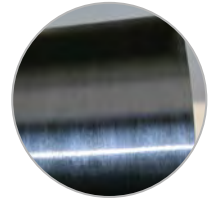
✓ Medical filtration

✓ Gas Filtration

✓ Nanofiltration



Prepreg

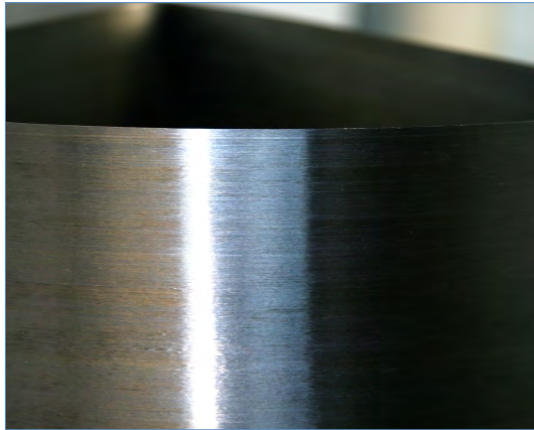


Markets:

✓ Automotive

✓ Aerospace

✓ Construction



Medical applications



Markets:

✓ Silicone Gels

✓ Hydrogels

✓ Plaster

✓ Surgical materials



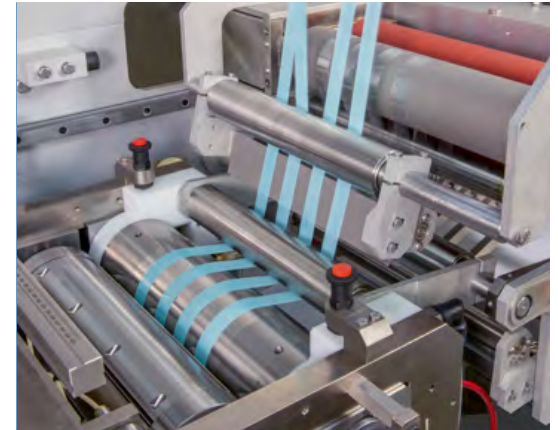
Pharmaceutics



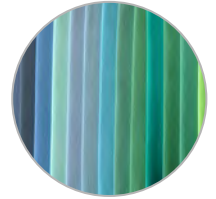
Markets:

✓ ODF (Oral Dispersible Film)

✓ Transdermal Systems



Textil



Markets:

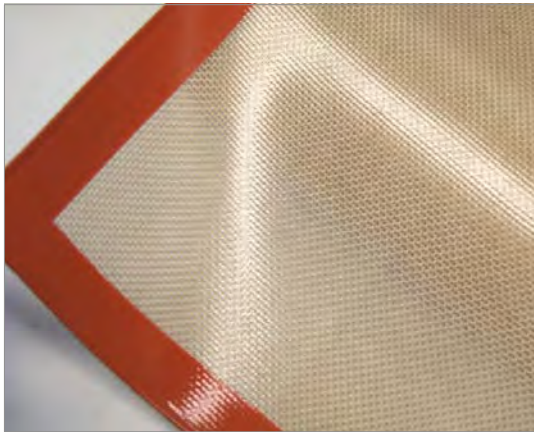
✓ Technical textiles

✓ Construction textiles

✓ Medical textiles

✓ Geotextiles

✓ Home textiles



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Lab units

Lab



Test Solution S2S



Easycoater



Test Solution R2R

Pilot lines

Pilot



Click & Coat™



Smartcoater



Basecoater 3rd Generation

Pilot lines

Pilot



Deskcoater



Linecoater



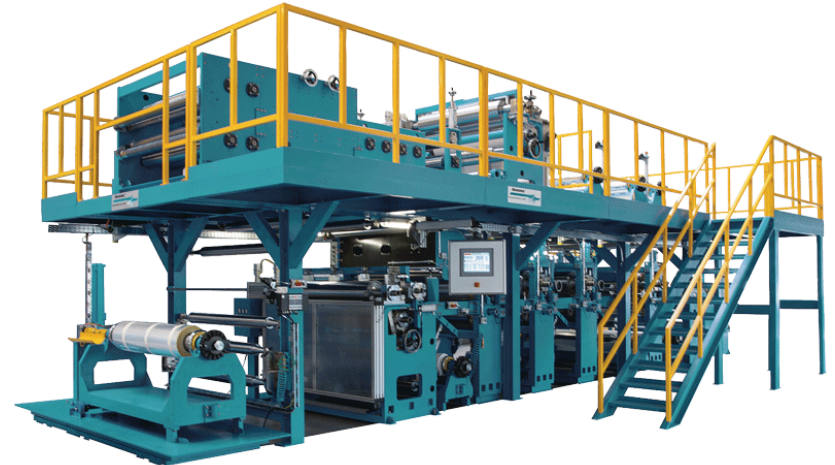
Verticoater

Production lines

Production



Production Lines



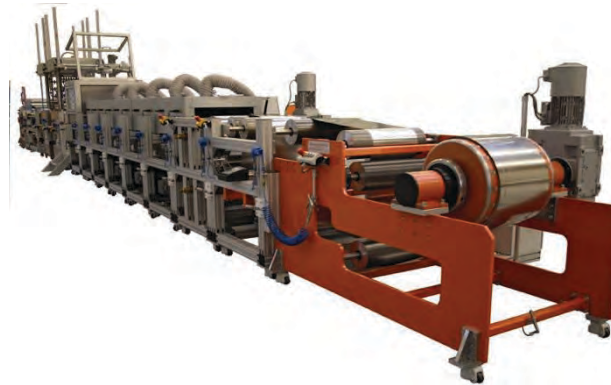
Prepreg Plant

Bespoke equipment

Custom
made



Printed Oleds



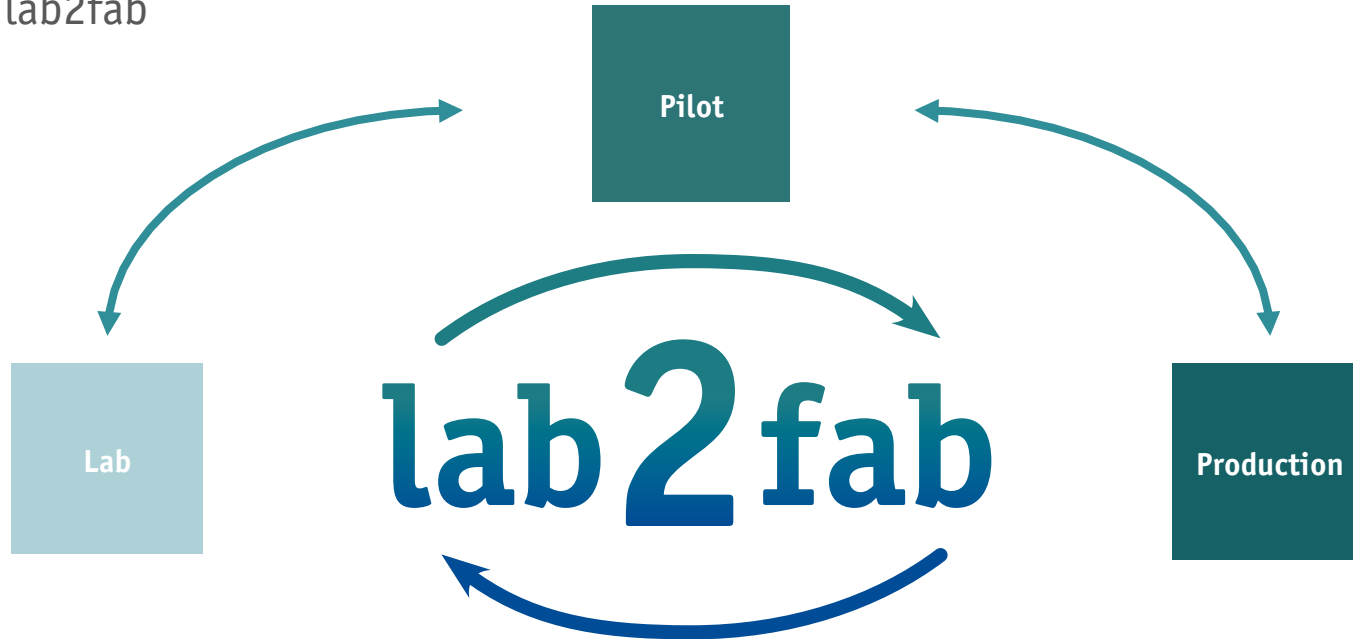
Battery



Composite Fibres

Scaling up new technologies

Tools for lab2fab



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R&D Power House

KROENERT – Drytec – Coatema

- ✓ R&D-Space: 2.000 m²
- ✓ R&D Units: 15
- ✓ From R2R to S2S
- ✓ Working width: 100 mm to 1,300 mm
- ✓ Operation Speed: 0.1 to 1,610 m/min.
- ✓ 15 parallel public funded R&D Projects
- ✓ R&D Staff: 25

Product portfolio:

- ✓ Basic research, Process- and Productdevelopment
- ✓ Product improvement
- ✓ Trainings and Conferences



R&D Centre KROENERT & DRYTEC



R&D Centre Coatema

Coatema R&D centre



Technologies

Coating, Printing, Laminating,
Imprinting, Pretreatment, Drying,
Curing, Cross linking, Cutting

Number of units available

10 – 12 units on 1.200 sqm

Sheet to Sheet – S2S

up to 300 mm x 500 mm

Roll to Roll – R2R

up to 500 mm width

Operation Speed

0.1 to 100 m/min.

Product portfolio

Process Development

- ✓ Feasibility study
- ✓ Ink – process study
- ✓ Process analysis
- ✓ Proof of concept
- ✓ Small scale prototype

Test Production

- ✓ Prototyping
- ✓ Near to market testing
- ✓ TRL evaluation
- ✓ Training of staff

Education

- ✓ Coatema Conference
- ✓ Training of customers
- ✓ Education of students

After sales service and ramp up of processes

- ✓ of Coatema units

Development of custom made design for equipment

- ✓ Prototyping
- ✓ Proof of concept

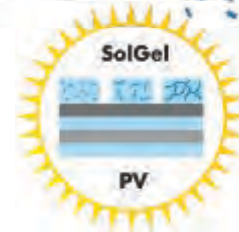
Funded Research Projects

- ✓ German funded
- ✓ Horizon 2020
- ✓ Global 2+2 projects
- ✓ B2B projects



R&D projects





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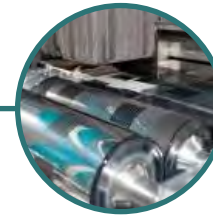
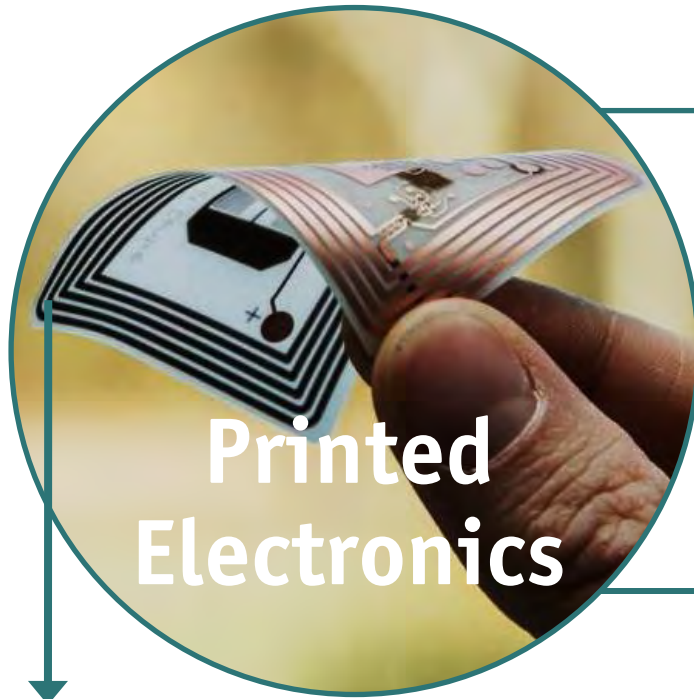
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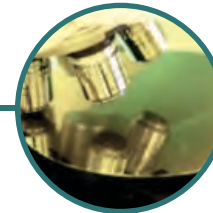
The future market



Printing
Coating
Deposition



Chemistry

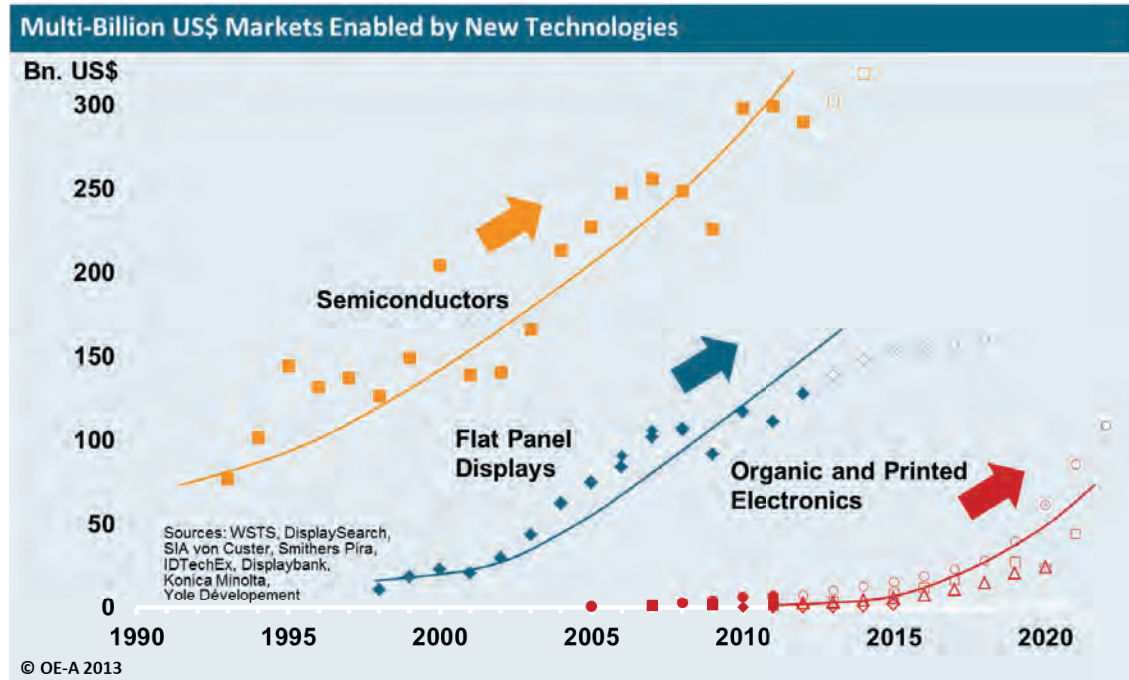


Microelectronics

flexible – thin – robust – lightweight – stretchable



The future market



2010

2 Billion US\$
predominantly by OLED displays

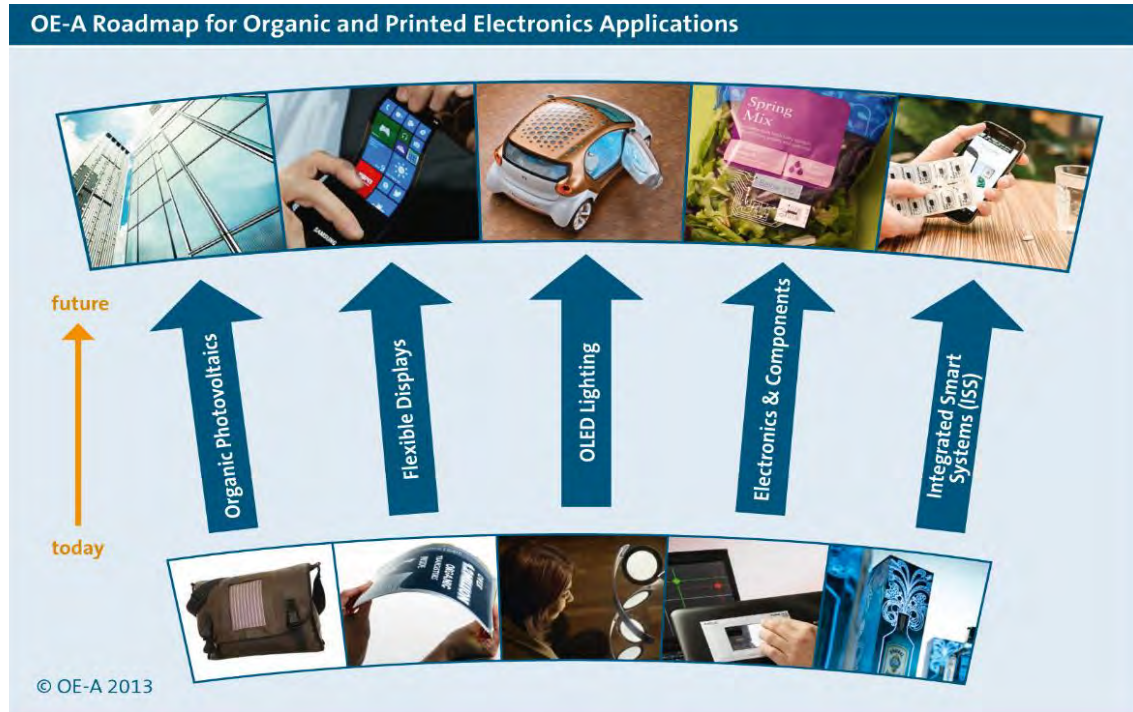
2012

8 Billion US\$
predominantly by OLED displays

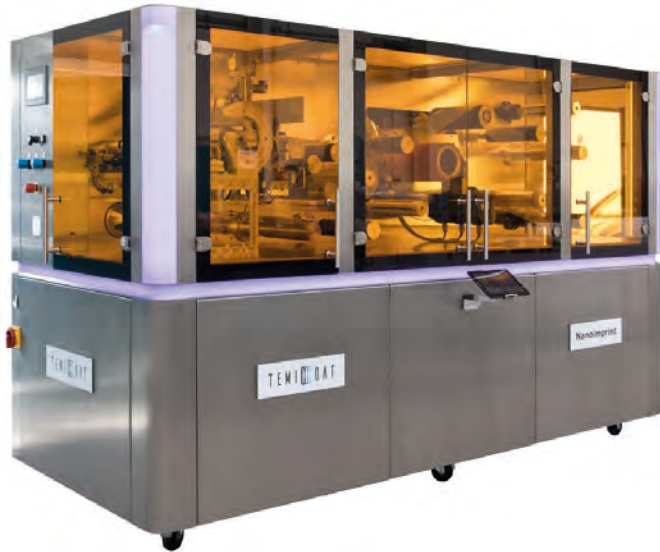
Potential

for a 50 Billion US\$ market
within the next 10 years
driven by
OPV, lighting, displays,
logic, memory/RFID,
sensors

The future market



Digital fabrication

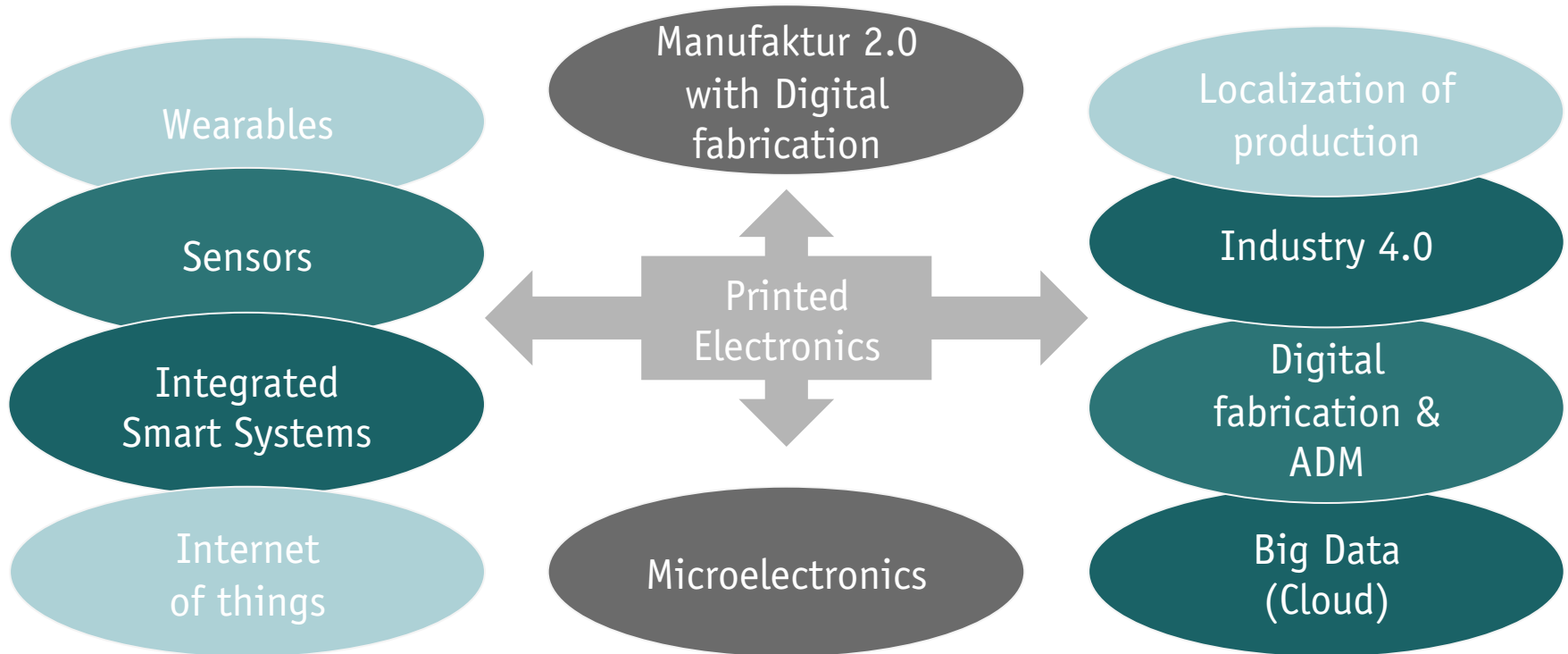


Digital fabrication is happening – Lot size 1 is real.

Why now?

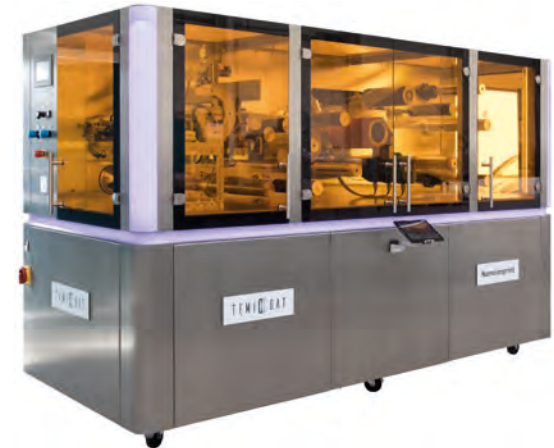
Digital fabrication and Additive manufacturing will disruptively change the world of manufacturing we know today!

Disruptive!

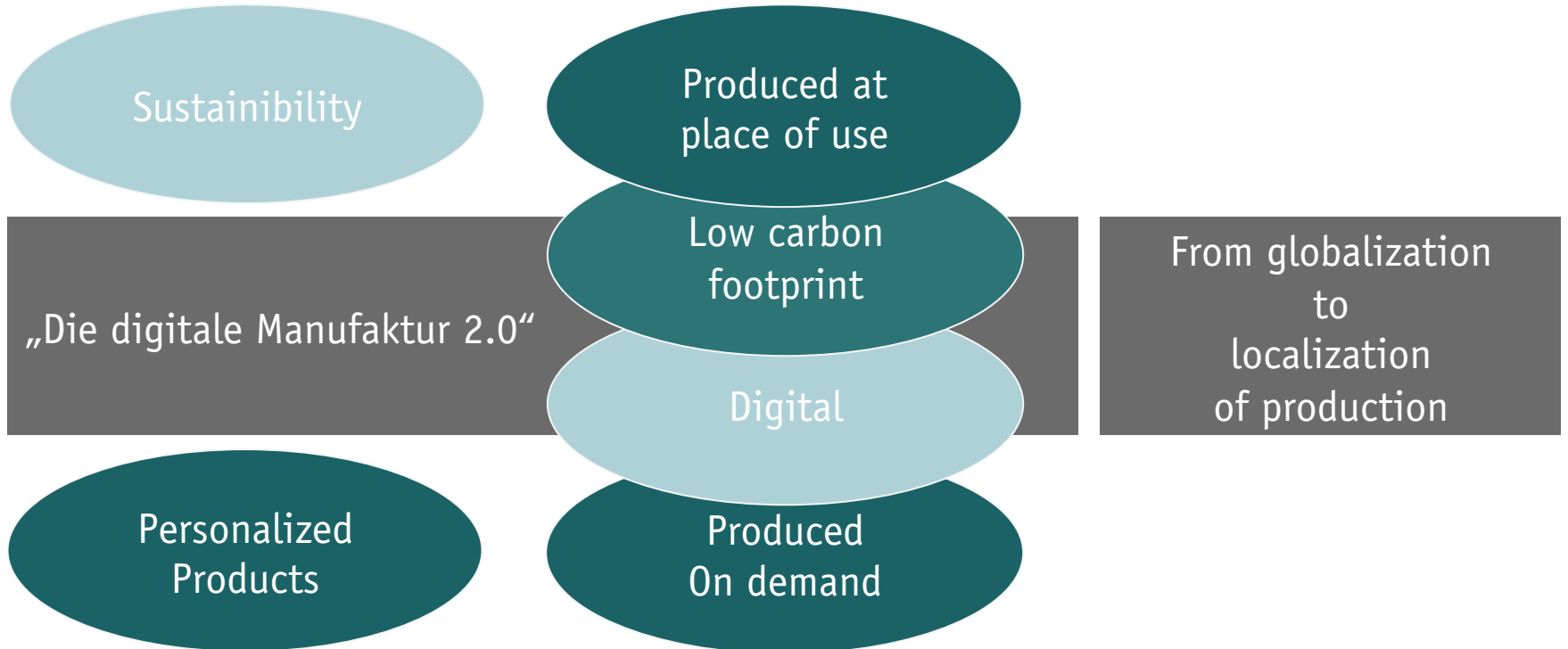


The „4th“ industrial revolution

- ✓ Digital fabrication means to have the ability to produce lot size one for the same cost as for lot size million.
- ✓ Manufacturing at the site with personalized design for each customer.
- ✓ It will change global manufacturing to local manufacturing.
- ✓ Productivity boost for the old economies and Europe, the real 4th revolution.
- ✓ The „Manufaktur“ will come back – as the „digitale Manufaktur 2.0“.



Disruptive



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From 2008 till today – PE as the flexible bridge



Actuator

Data processing

Energy source/
Energy harvesting

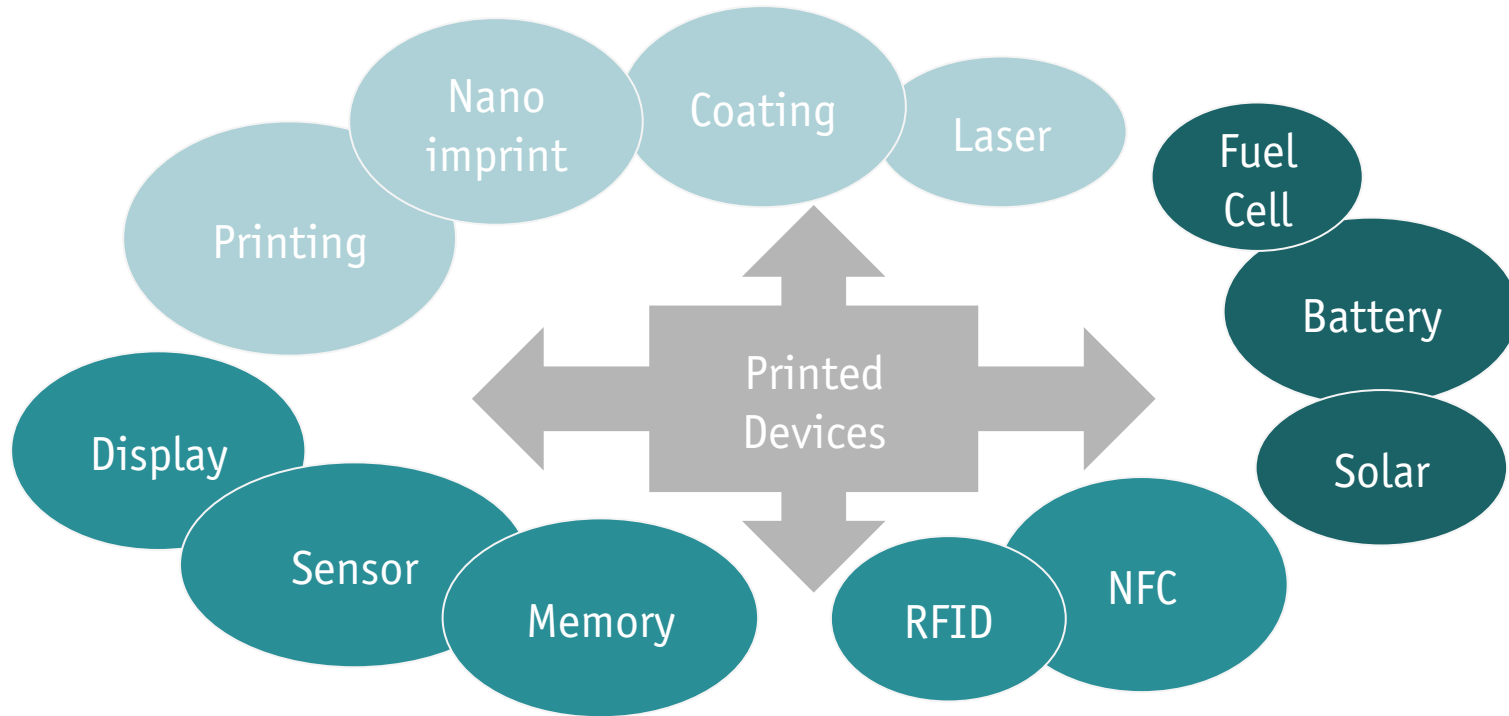


Sensor

Data transmission

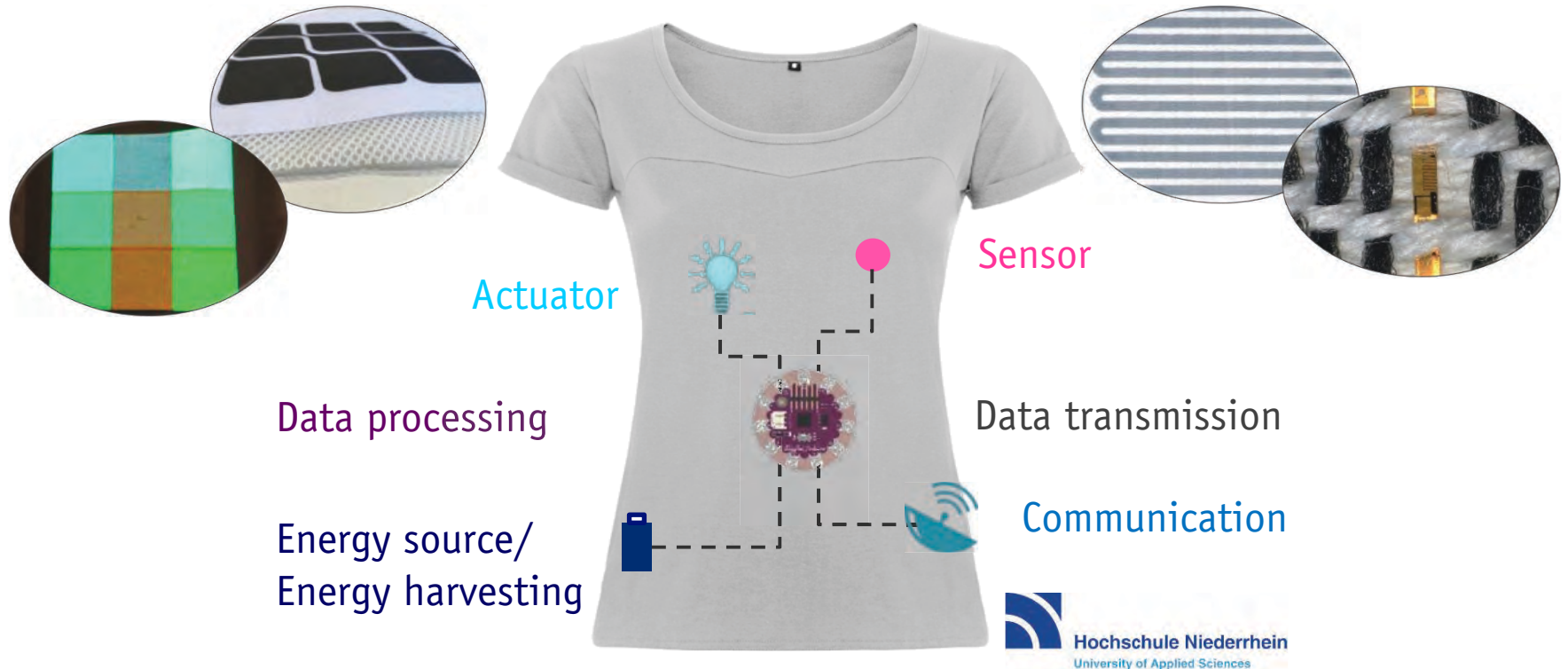
Communication

Printed electronics – Bridging the gap

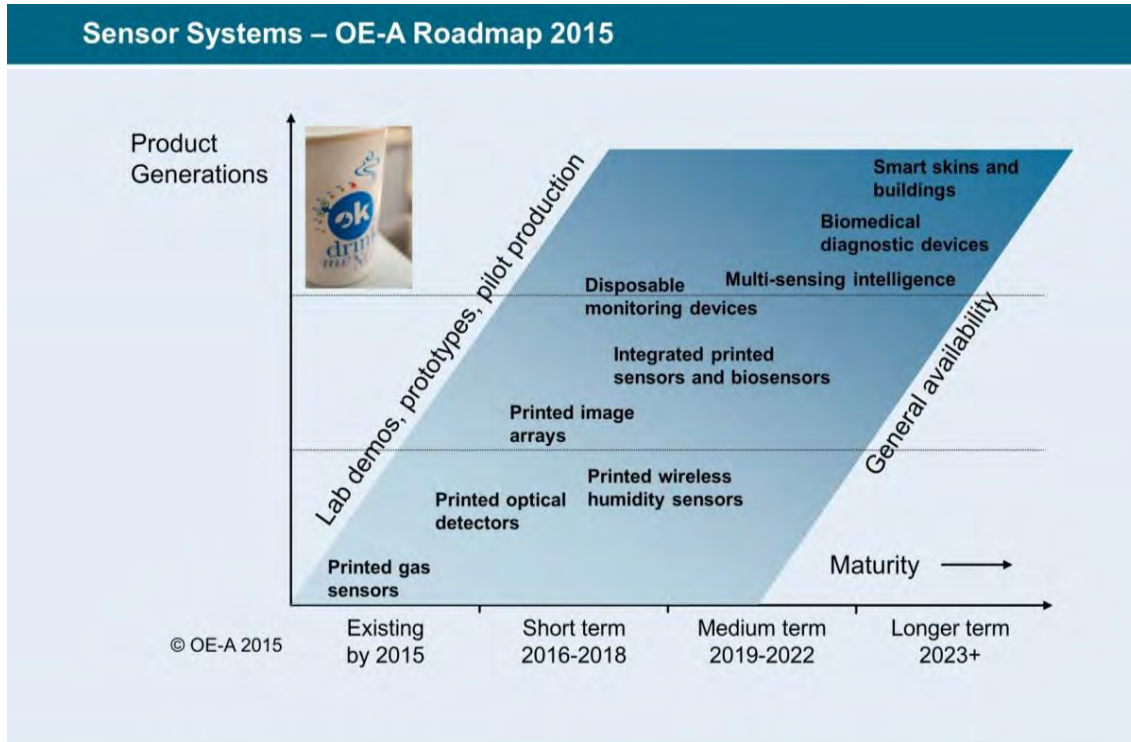


What could be the pathway on to textiles or also integrated into textiles?

From 2008 till today – PE as the flexible bridge



Sensor Systems – Roadmap 2015



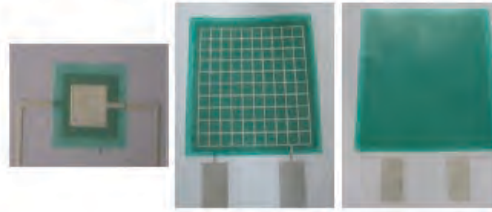
Case Study – Design principles

Authors: Juha-Veikko Voutilainen, Tuomas Happonen, University of Oulu



Figure 1. Printed temperature sensor and layout

Authors: Tuomas Happonen, Juha-Veikko Voutilainen, University of Oulu



(a) (b) (c)

Figure 1. Printed capacitive humidity sensor structures



Figure 1. Electrochemical biosensor

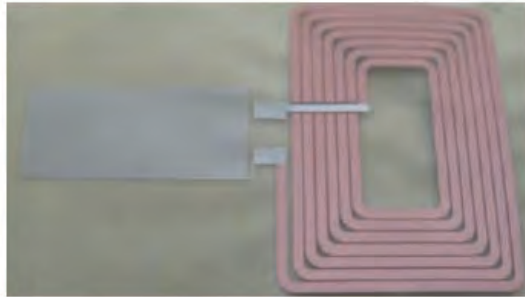


Figure 2. A remote readable RH sensor.

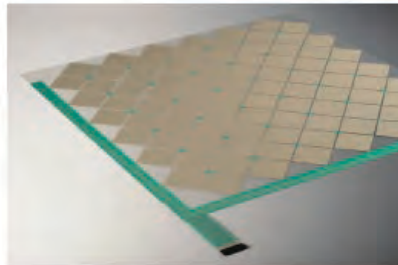


Figure 1. Capacitive touch sensor

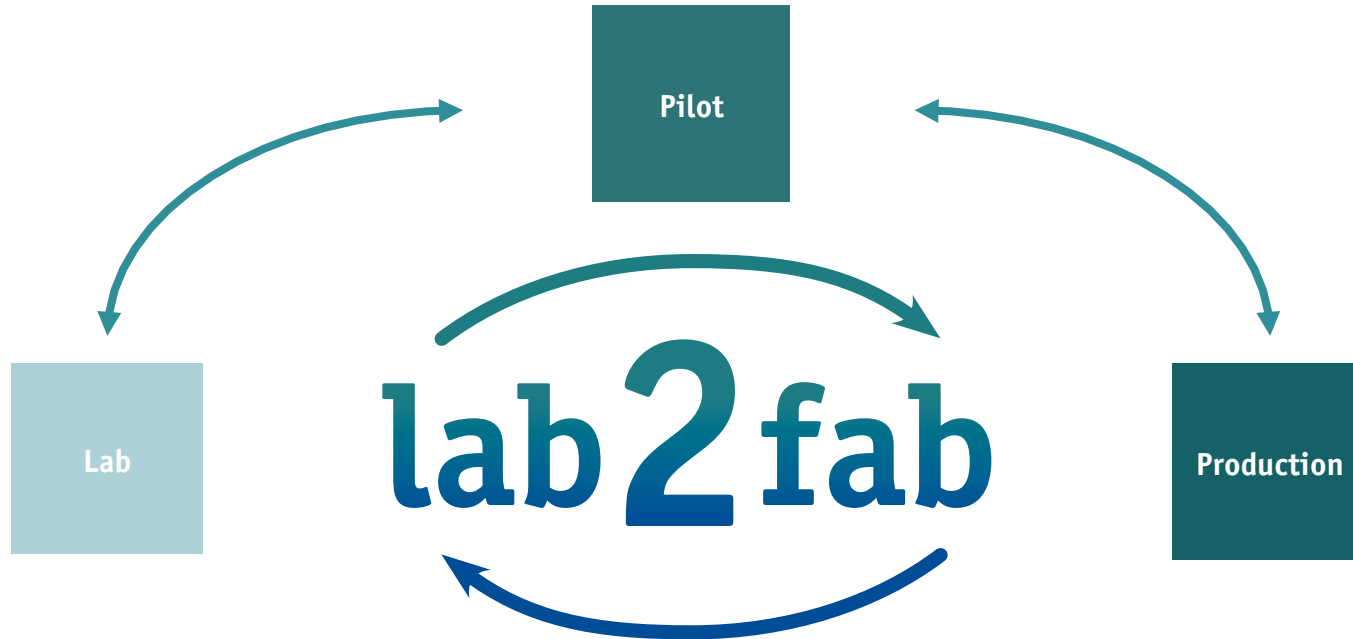
Authors: Elina Jansson, Jukka Hast, VTT



Figure 1. Printed gas sensors



Tools for Lab2Fab



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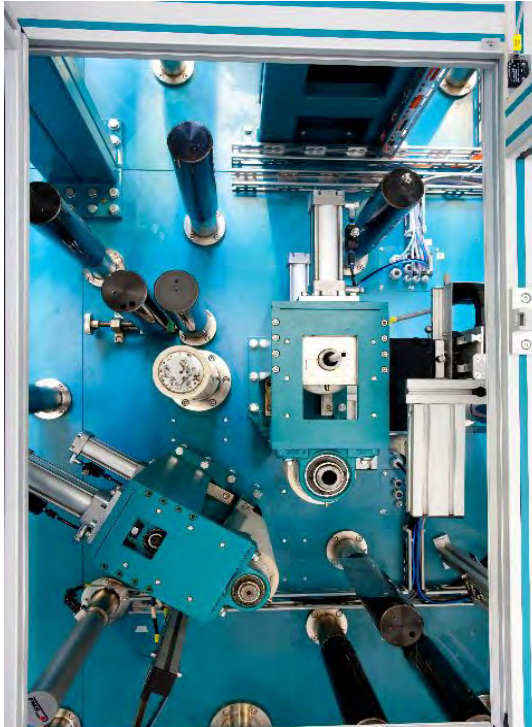
Coating Parameters

Coating Chemistry	Coating Processes	Process control	Drying
<ul style="list-style-type: none"> ✓ Rheology ✓ Viscosity ✓ Viscoelasticity ✓ Type of solvents ✓ Amount of solids ✓ Van der Waals force ✓ Sheer ratio ✓ Adhesion/Cohesion 	<ul style="list-style-type: none"> ✓ Coating systems ✓ Single or Multilayer coatings ✓ Direct coatings ✓ Transfer (indirect) coatings ✓ Substrate speed ✓ Layer Thickness ✓ Coating accuracy 	<ul style="list-style-type: none"> ✓ Process layout ✓ Tension control system ✓ Material guiding system ✓ Inline parameter control ✓ Quality control 	<ul style="list-style-type: none"> ✓ Convection drying ✓ Contact drying ✓ Infrared drying ✓ Sintering ✓ NIR ✓ High Frequency ✓ UV crosslinking systems
Substrate	Pretreatment	Environment	Finishing
<ul style="list-style-type: none"> ✓ Surface tension ✓ Dimension stability ✓ Surface structure ✓ Contact angle 	<ul style="list-style-type: none"> ✓ Corona ✓ Plasma ✓ Cleaning 	<ul style="list-style-type: none"> ✓ Humidity ✓ Temperature ✓ Inert Conditions 	<ul style="list-style-type: none"> ✓ Calendaring ✓ Embossing ✓ Slitting

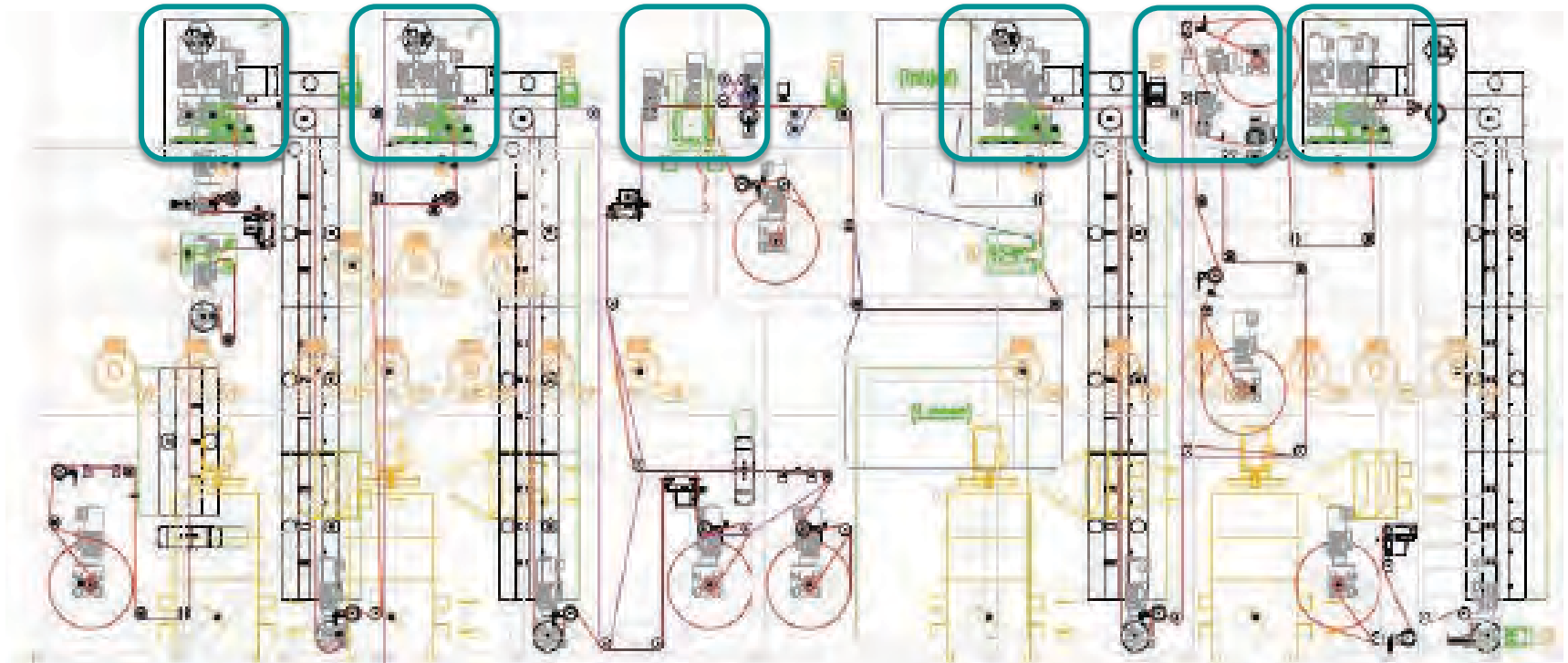
Processes



Upscaling from Lab2Fab – Going to Fab-Technologies



From Lab2Fab



Process Parameters

Process Parameters are:

- ✓ Operation speed
- ✓ Rheology of coating and printing inks
- ✓ Substrate condition
- ✓ Tension control MD / CD
- ✓ Edge control
- ✓ Resolution and registration accuracy of printing / laminating systems
- ✓ Precision of coating operations
- ✓ Curing / drying / crosslinking

Inline Process Integration

Tension control

- ✓ Load cell
- ✓ Dancer
- ✓ Pulling devices
- ✓ Design of drives

Edge guide control

- ✓ Different sensors
- ✓ Mechanical stress

Quality control

- ✓ Particle contamination analysis
- ✓ Defect detection
- ✓ Thickness control
- ✓ Function control of the device or layer

Registration control

- ✓ Camera
- ✓ Fiber optic
- ✓ Design of drives

Process analysis

- ✓ Statistic parameters
- ✓ Product flow analysis
- ✓ Yield
- ✓ Cost of ownership

Inline Process Integration



smartonics

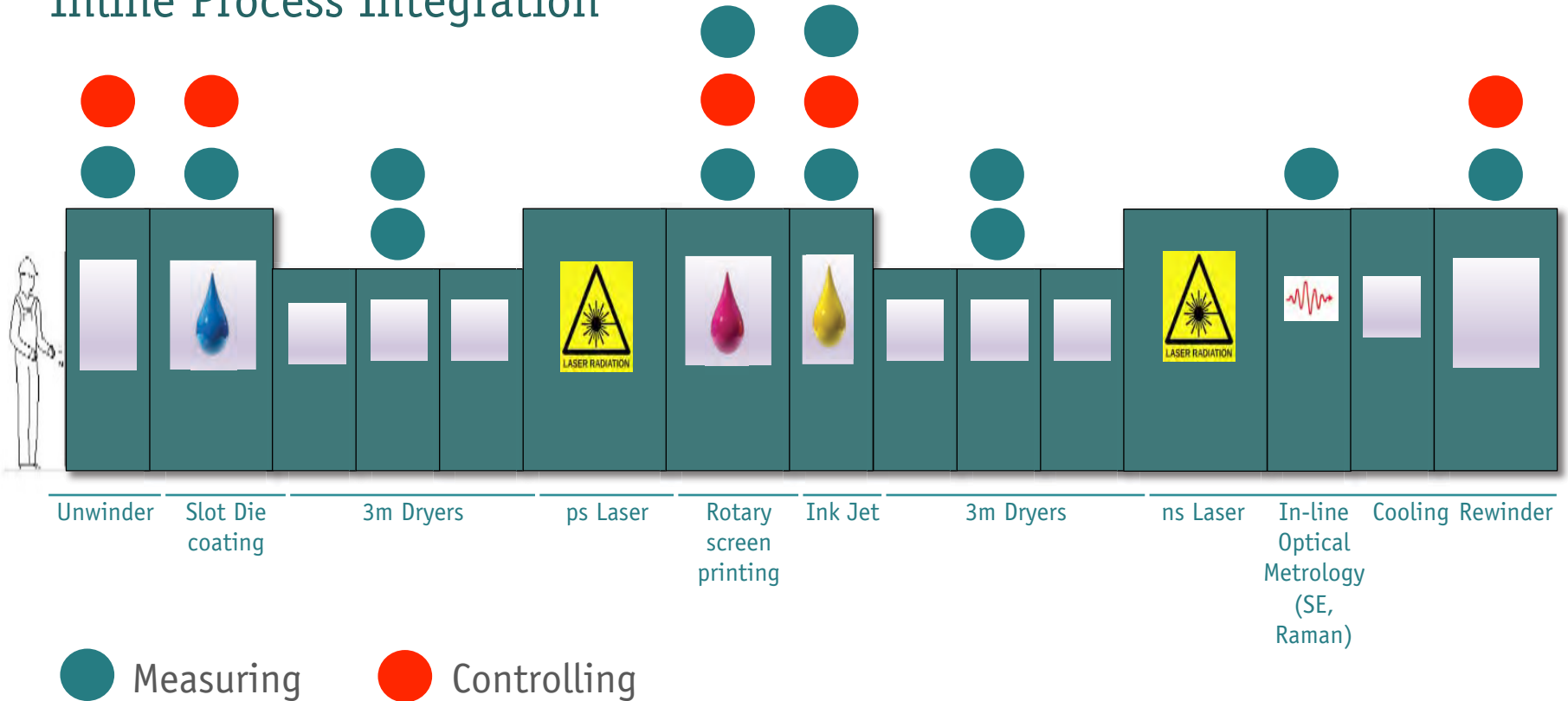


This project is funded by
the European Union

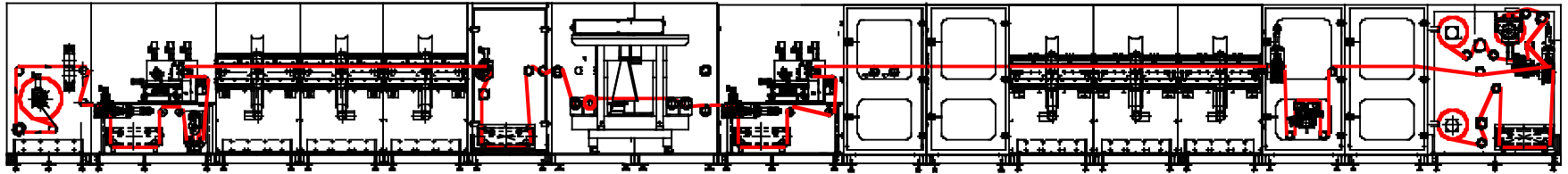
**Development of smart machines, tools and processes for the precision synthesis
of nanomaterials with tailored properties for Organic Electronics**

The project SMARTONICS receives funding from the European Union Seventh Framework Programme (FP7/2007-2013) under grant agreement no 310229.

Inline Process Integration



Inline Process Integration



Winding / Cleaning



Unwinding cabinet

- ✓ Can receive rolls with core of 3 inch
- ✓ Max diameter of 500 mm
- ✓ Max weight 50 kg
- ✓ Web width of 300 mm
- ✓ Automated forward and reverse movement of the web
- ✓ Speed of 1 – 20 m/min.
- ✓ Tension control of the web within the range of 5 – 250 N

Web Cleaning system

- ✓ Contact cleaning rollers for particles of $>1\mu\text{m}$ diameter

Inline Process Integration



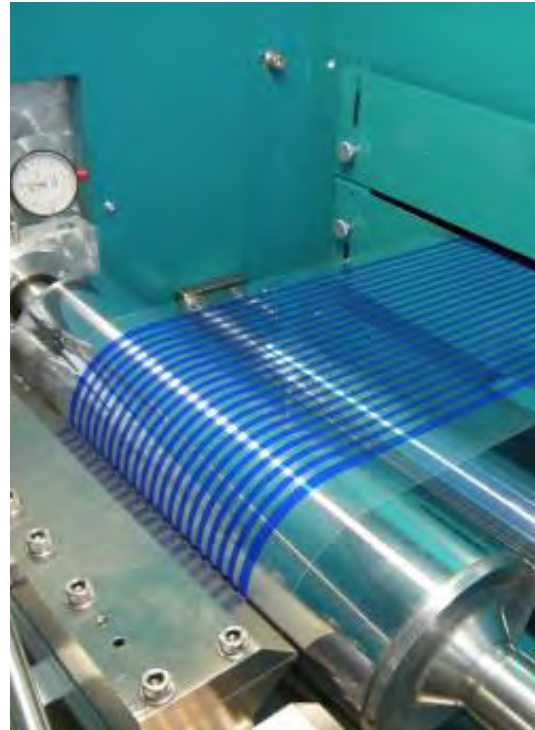
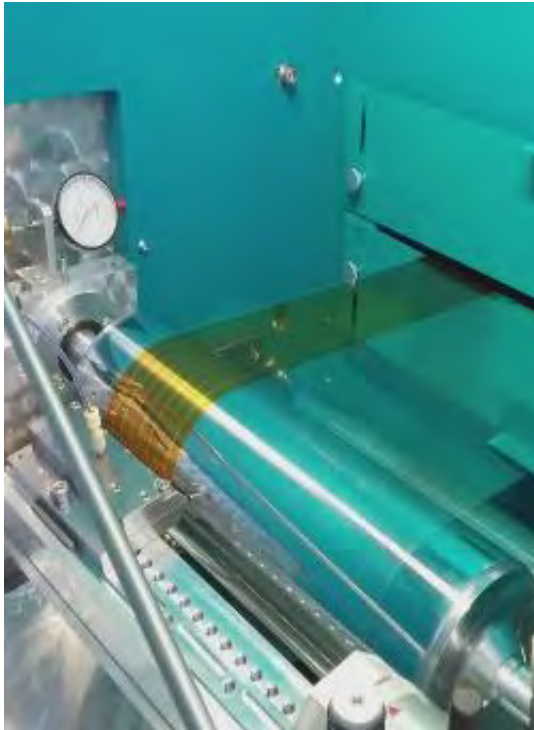
1st Printing

- ✓ Web surface activation with Plasma Treatment

Dryer 1

- ✓ 3 meter Dryers
- ✓ Hot Air and heated nitrogen
- ✓ Temperatures up to 230°C

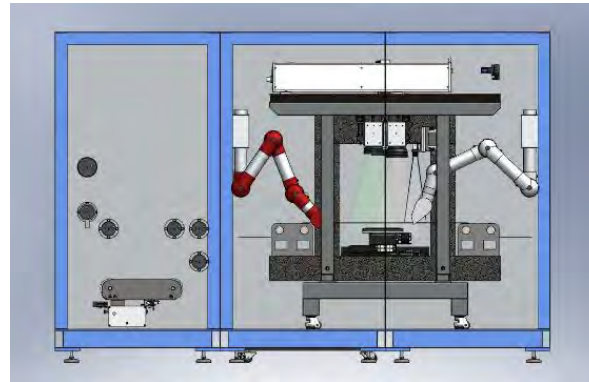
Slot die coating



Slot-die coating station compatible for materials used in OEs

- ✓ Print solutions with viscosity range of 10 – 1000 mPa · s
- ✓ The above range can lead to layer thickness range of 10 – 1000nm
- ✓ Lateral accuracy of $\pm 1\%$

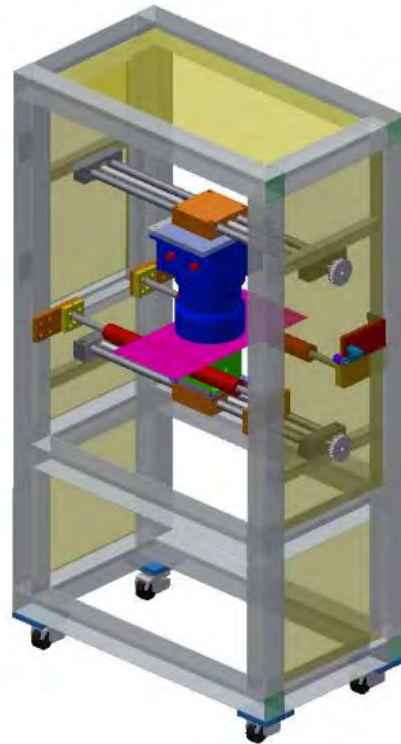
Laser Patterning



Laser Scribing/Patterning

- ✓ Picosecond laser for patterning OE materials
- ✓ 3 meters cabinets
- ✓ Tension and driving web control
- ✓ System $\pm 100 \mu\text{m}$ of accuracy

Module for the registration Camera



Technical Specifications:

- ✓ Measurement Accuracy = $\pm 20 \mu\text{m}$
- ✓ ATEX proof
- ✓ 300 mm roller width
- ✓ Web speed:
1–20 m/min; Optimum speed is 3 – 20 m/min.
- ✓ PLC-driven correction adjustment system
- ✓ Module to be operated under N_2

Rotary screen printing



2nd Printing Station

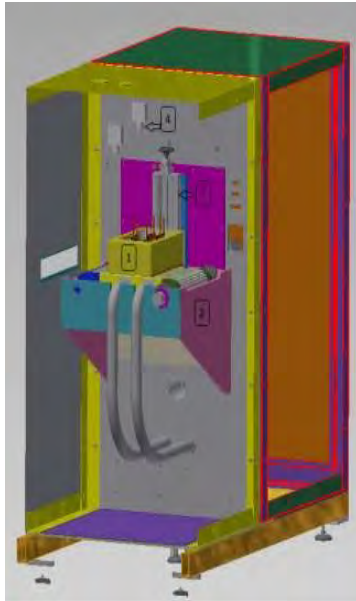
- ✓ Rotary screen printing
- ✓ Coating width of 300mm
- ✓ Lateral accuracy $\pm 5\%$

Dryer 2

- ✓ 3 meters Dryers
- ✓ Hot Air and heated nitrogen
- ✓ Temperatures up to 230°C

Inline Process Integration

Inkjet station



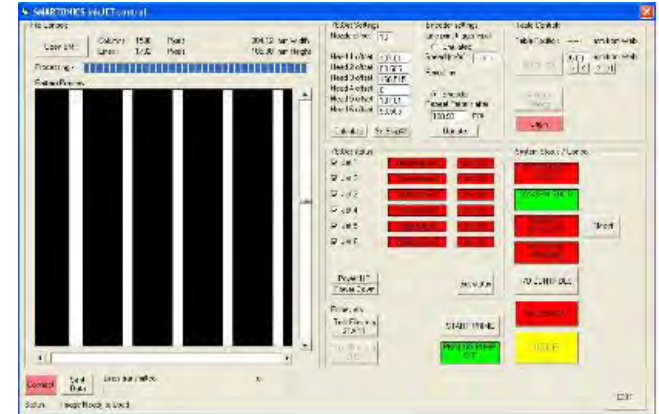
Inkjet station



System



Coatema Software



Already integrated:
Fujifilm Dimatix

Encapsulation



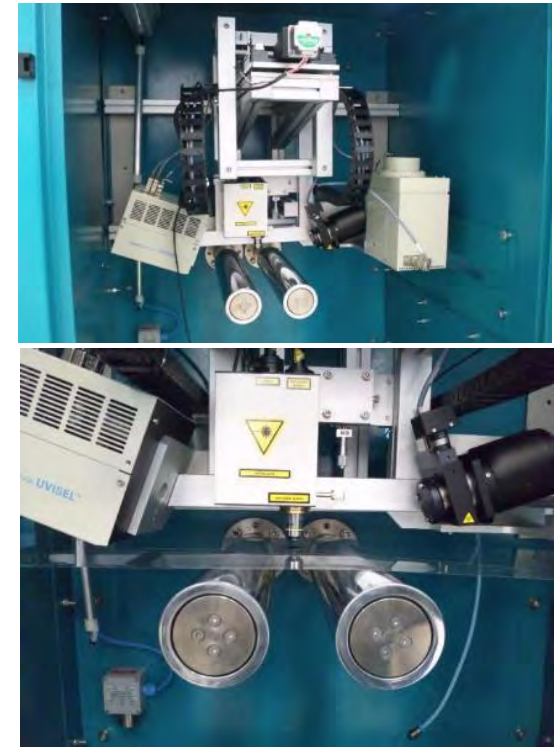
Rewinding station

- ✓ The rewinding station has a retaining roller
- ✓ Identical specs to the unwinding station
 - ✓ 3 inch core rolls
 - ✓ Automated forward and reverse movement of the web
 - ✓ Speed of 1 – 20 m/min.
 - ✓ Tension control and Edge guide system

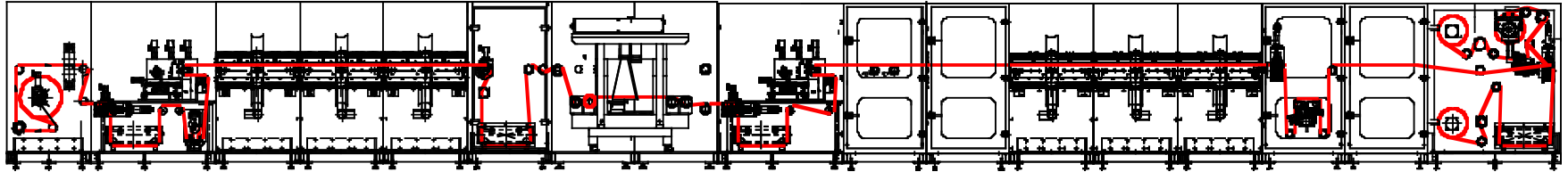
Lamination/delamination station

- ✓ Compatible with 300 mm web width
- ✓ Web Control with Edge guide system
- ✓ Lateral accuracy of $\pm 100 \mu\text{m}$ / $20 \mu\text{m}$

Inline Quality control – Ellipsiometry and inline Raman by Horiba



Summary



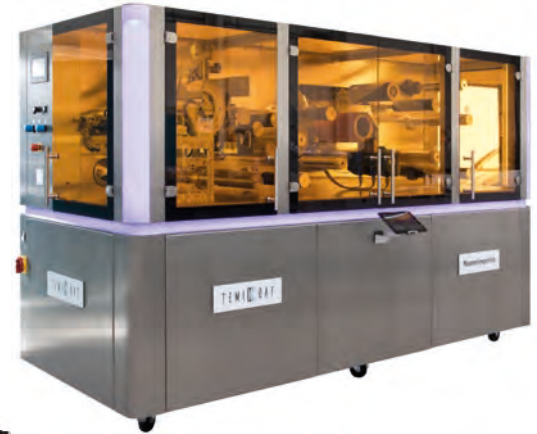
- ✓ 19 m in length
- ✓ 300 mm working width
- ✓ 30 m/min. per minutes production speed
- ✓ 3 print stations
- ✓ Plasma treatment
- ✓ 6.000 mm nitrogen dryers in 500 mm sections
- ✓ Registration control
- ✓ Laminating station



New design principle

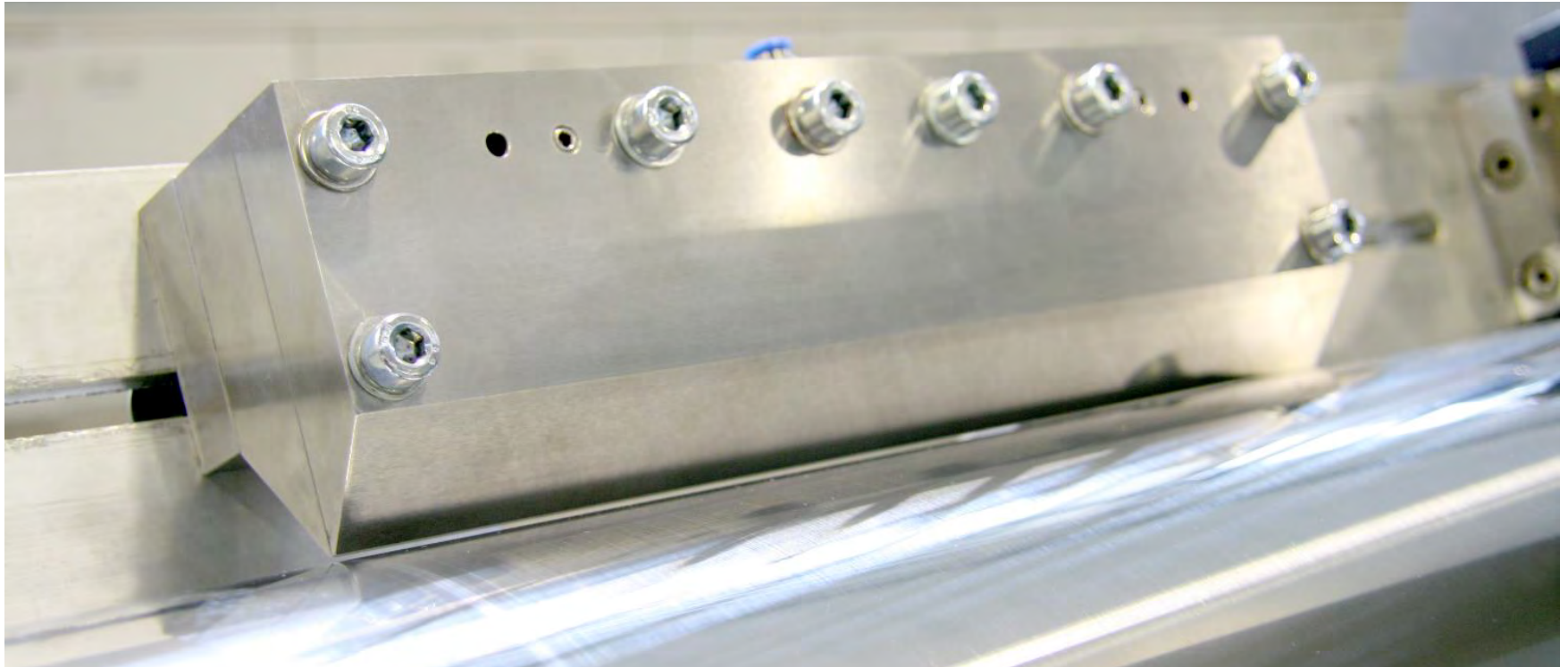


New design principle



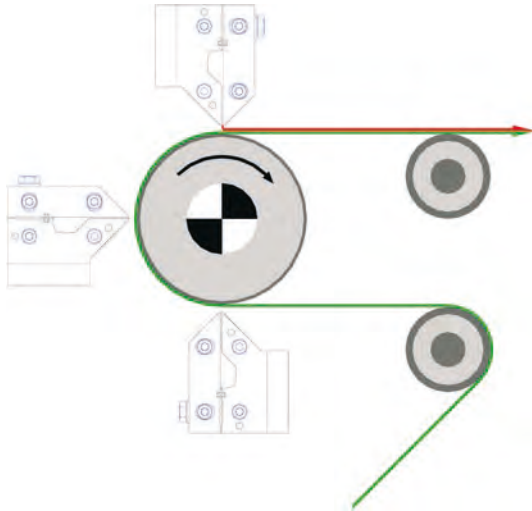


Slot Die system



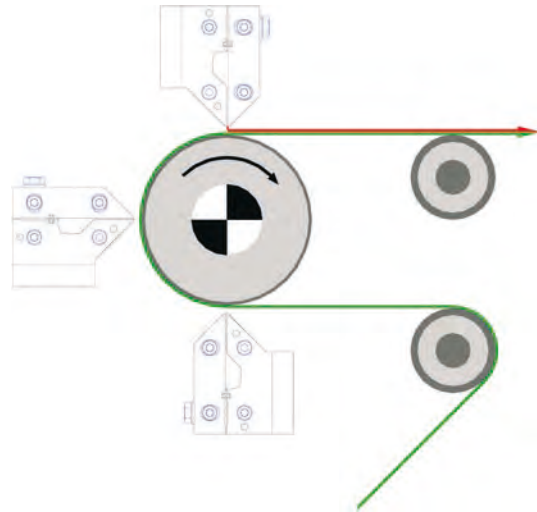
Basics of Slot Die coating – Characteristics of Slot Dies

- ✓ Homogeneous, thin layers
- ✓ Dosing (metering) system
- ✓ Touchfree (except in impregnation mode)
- ✓ Closed system (no evaporation of solvents)
- ✓ Full area non stop coating or intermittent



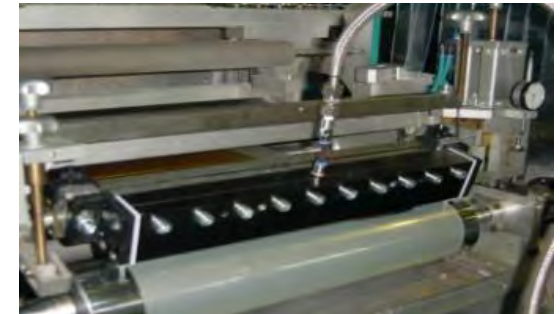
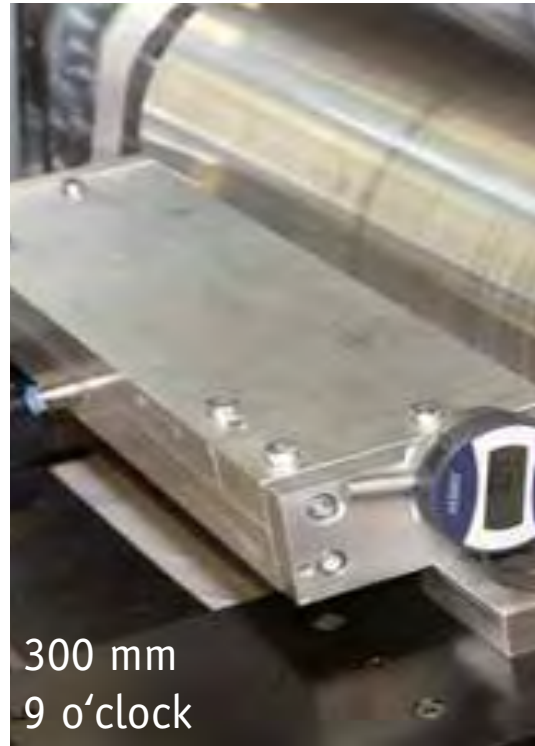
The Slot Die is the only system, that combines all these features.

Basics of Slot Die coating – Range of parameters



- ✓ Printing Speed (m/min) 0.1 – >1000
- ✓ Ink viscosity (mPa s) 1 – 30.000
- ✓ Layer Thickness 0,1 – >200 μ m
- ✓ Coating accuracy <1% (2 – 5%)
- ✓ Coating width up to approx. 3 m

Basics of Slot Die coating – Slot Die examples

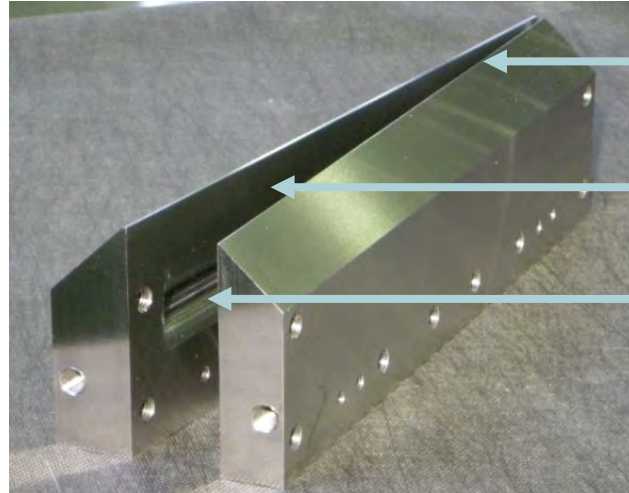
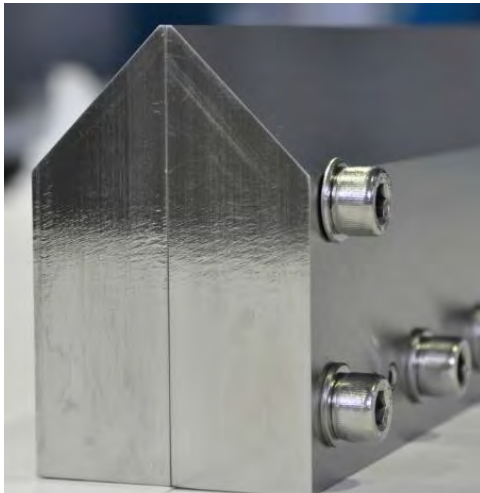


500 mm, slightly, tilted



300 mm, double sided

Basics of Slot Die coating – Coatema standard layout







lips

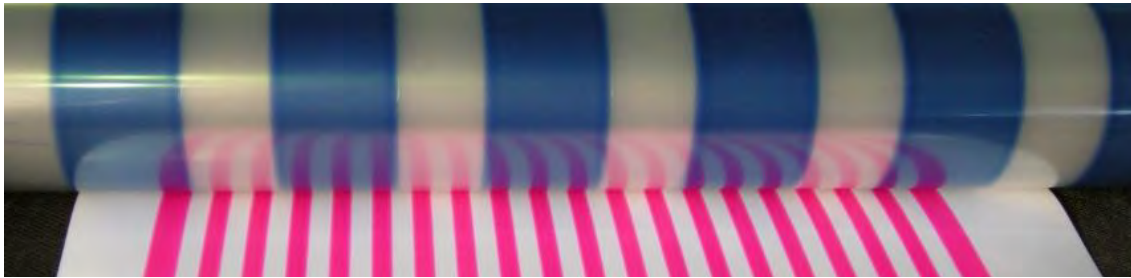
slot area

manifold

Structured coating – Levels of complexity

		Web direction	
		→	
1		full area, homogeneous	requirements are met, thickness profile variation of 0.5 %
2		stripes downweb	requirements are met, good edge definition
3		stripes crossweb (intermittent coating)	requirements are partially met, edge definition of 0.5 – 1 mm depending on liquid
4		arbitrary patterns	requirements are not met, concepts for realization exist, research project is going on

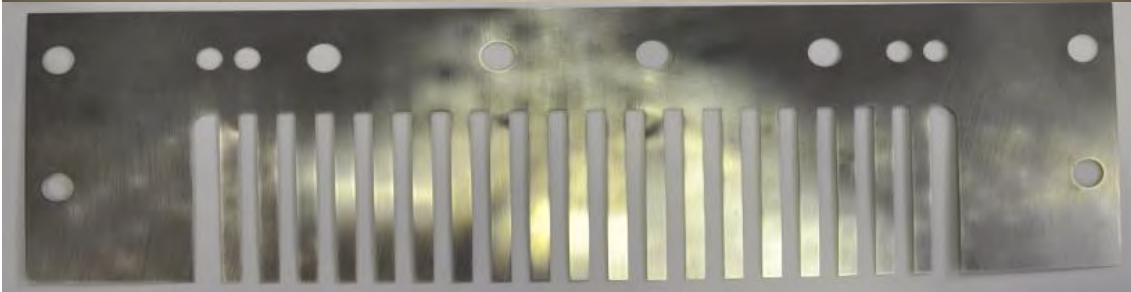
Structured coating – Downweb stripes



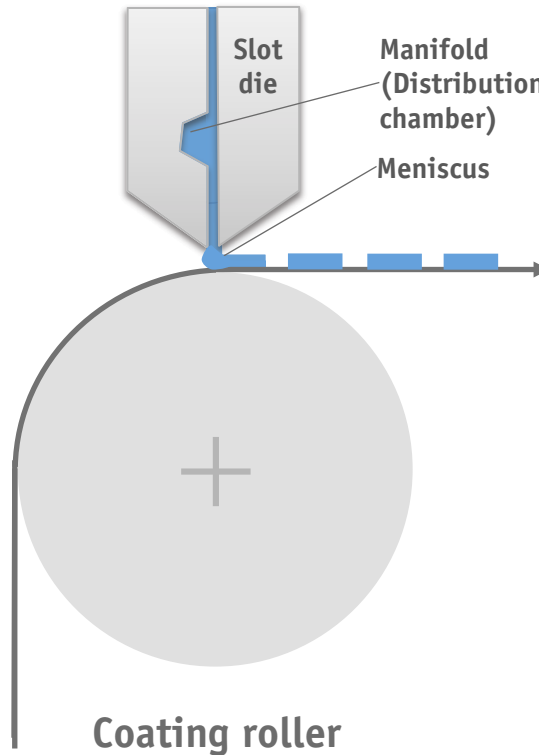
Downweb stripes of different width ...



... are made by appropriate shims, lasercut from steel or kapton



Structured coating – Crossweb stripes (intermittent)



Intermittent coating requires sudden start / stop of the fluid flow.

Different methods are available.

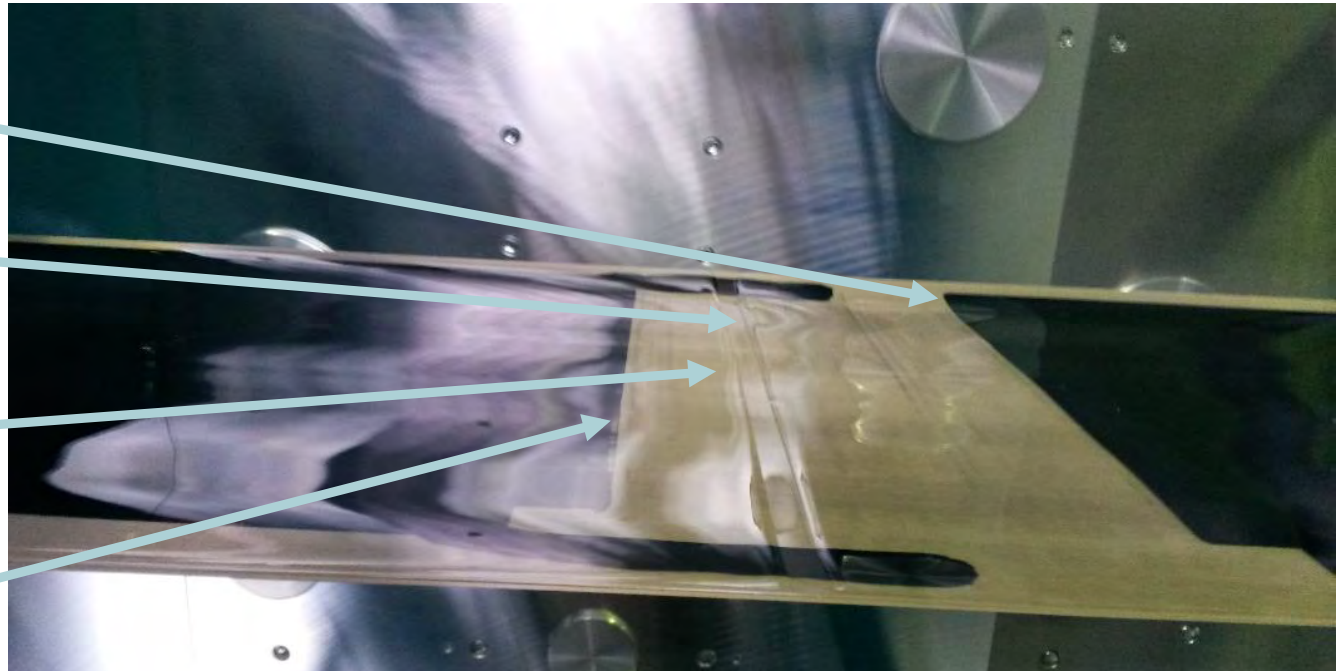
Structured coating – well defined edges at high viscosity

Leading edge
Battery paste

Leading edge
Silicone

Trailing edge
Silicone

Trailing edge
Battery paste

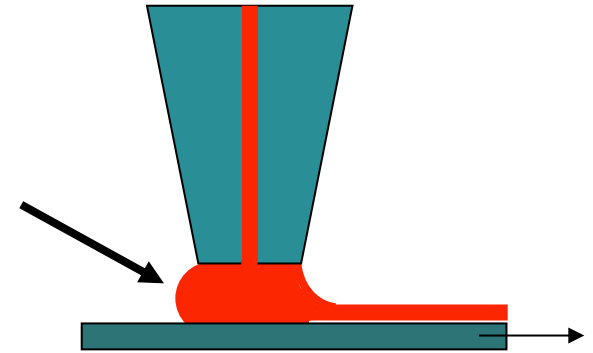


Two different stripe patterns, one on top of the other

Structured coating – reason for bad edges at low viscosity

The meniscus volume between the slot die and the substrate has to be interrupted. Low viscous liquids do not break along a straight line. So the meniscus has to be sucked back and restored as fast as possible to achieve a clear edge .

If the viscosity is too low, all of the three above mentioned methods are too slow and too indirect to do this.



Structured coating – new concepts for low viscosity liquids

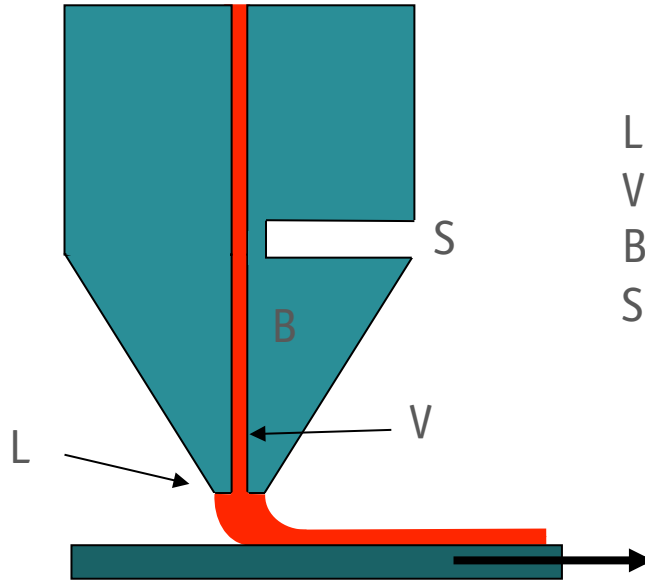
Two new concepts allow to interrupt and restore the meniscus much faster:

- ✓ Double chamber Slot Die
with modified chamber geometry and Piezo driven suck back pump
- ✓ Switching lip Slot Die
with a Piezo driven lip opening mechanism
that sucks back the meniscus right where it is



Structured coating – The switching slot die lip

Slot die with movable lips:
coating mode



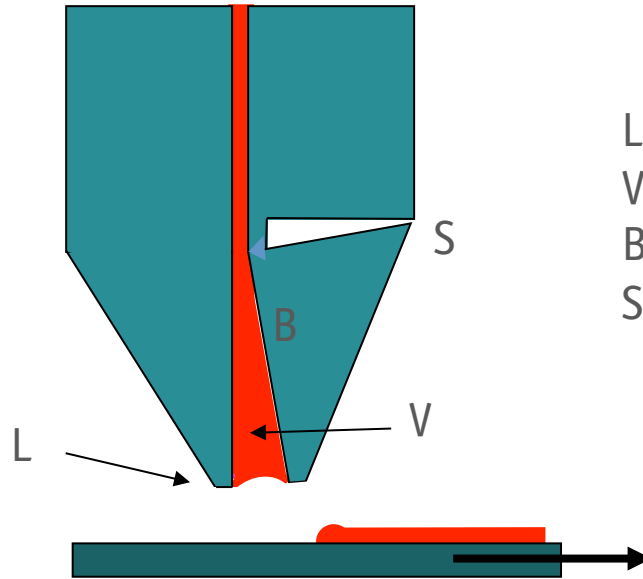
- L lip
- V slot volume
- B bendable lip
- S bending slot

coating works as usual



Structured coating – The switching slot die lip

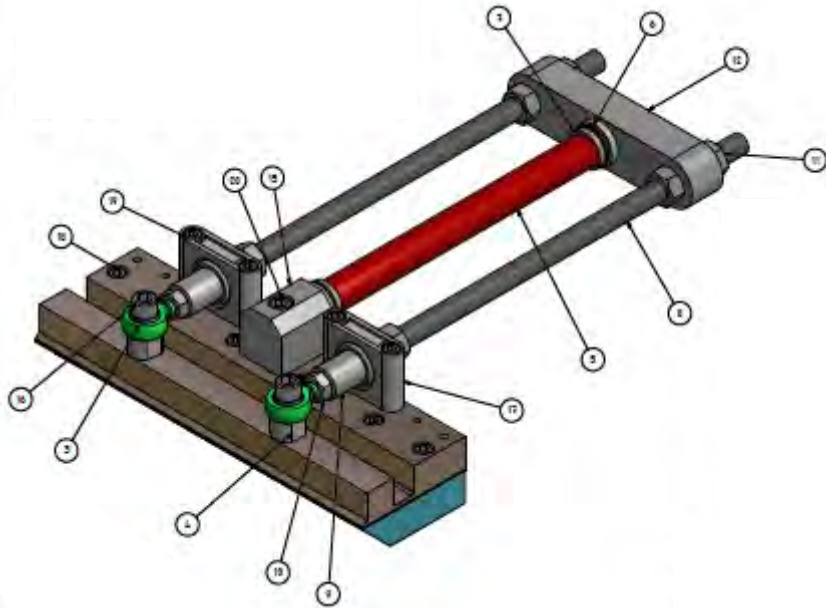
Slot die with movable lips:
stop mode



- L lip
- V slot volume
- B bendable lip
- S bending slot

Member B flips open
Volume V increases and
sucks away the meniscus

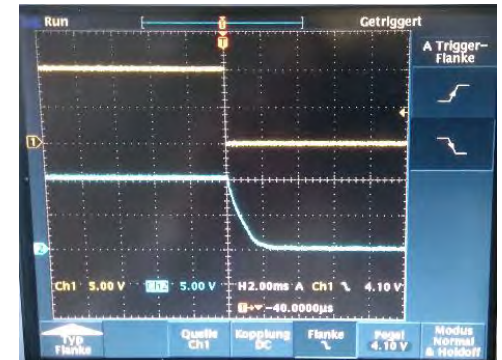
Structured coating – technical realisation with Piezo-Drive



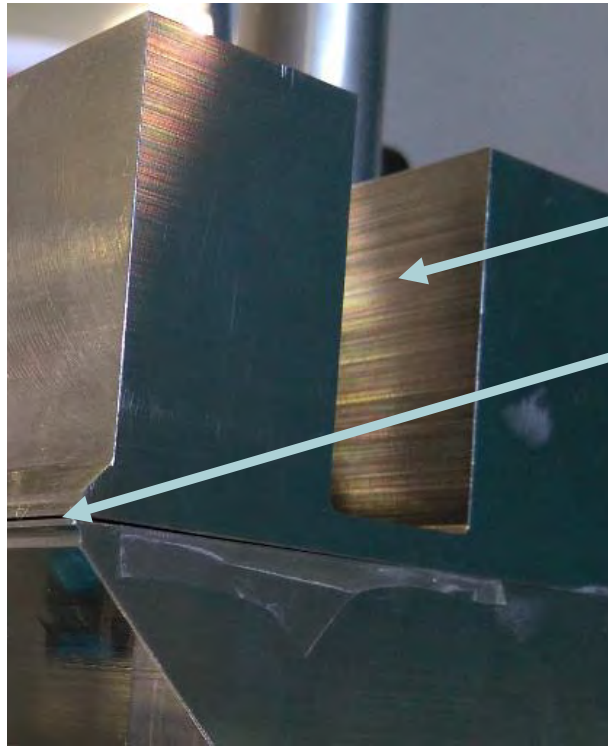
Extremely fast action:
within few ms from coating to stop
mode and vice versa

Control
Voltage

Piezo
Response



Structured coating – technical realisation with bendable lips

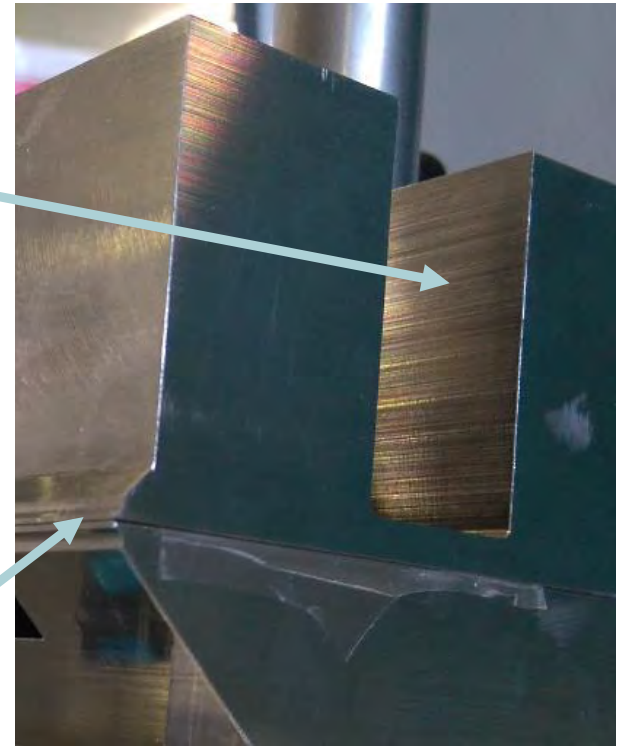


Bending slot

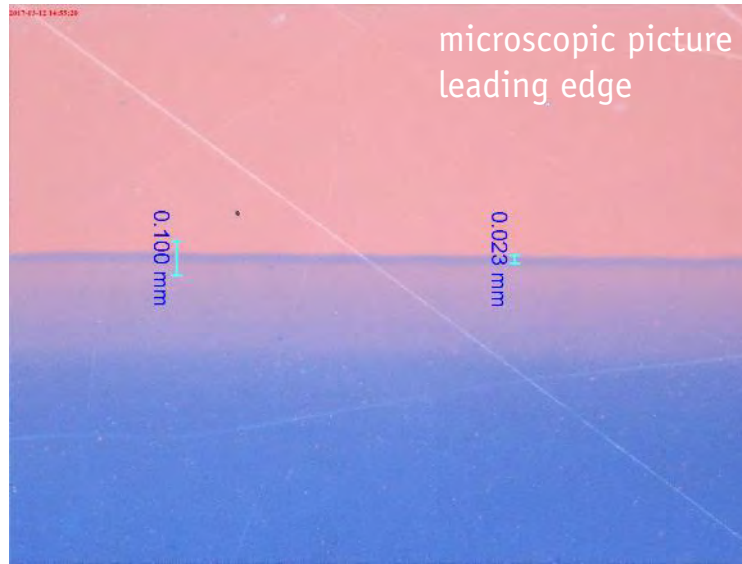
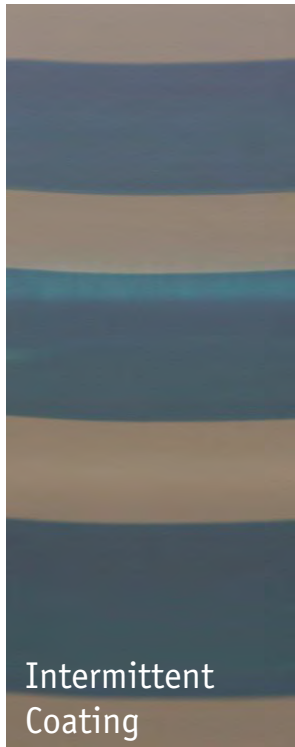
Lips open

**Difference
is 300 µm only**

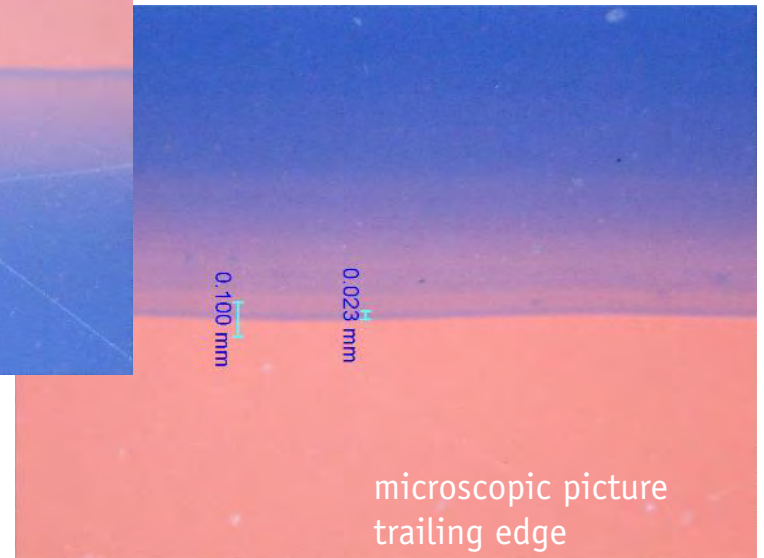
Lips closed



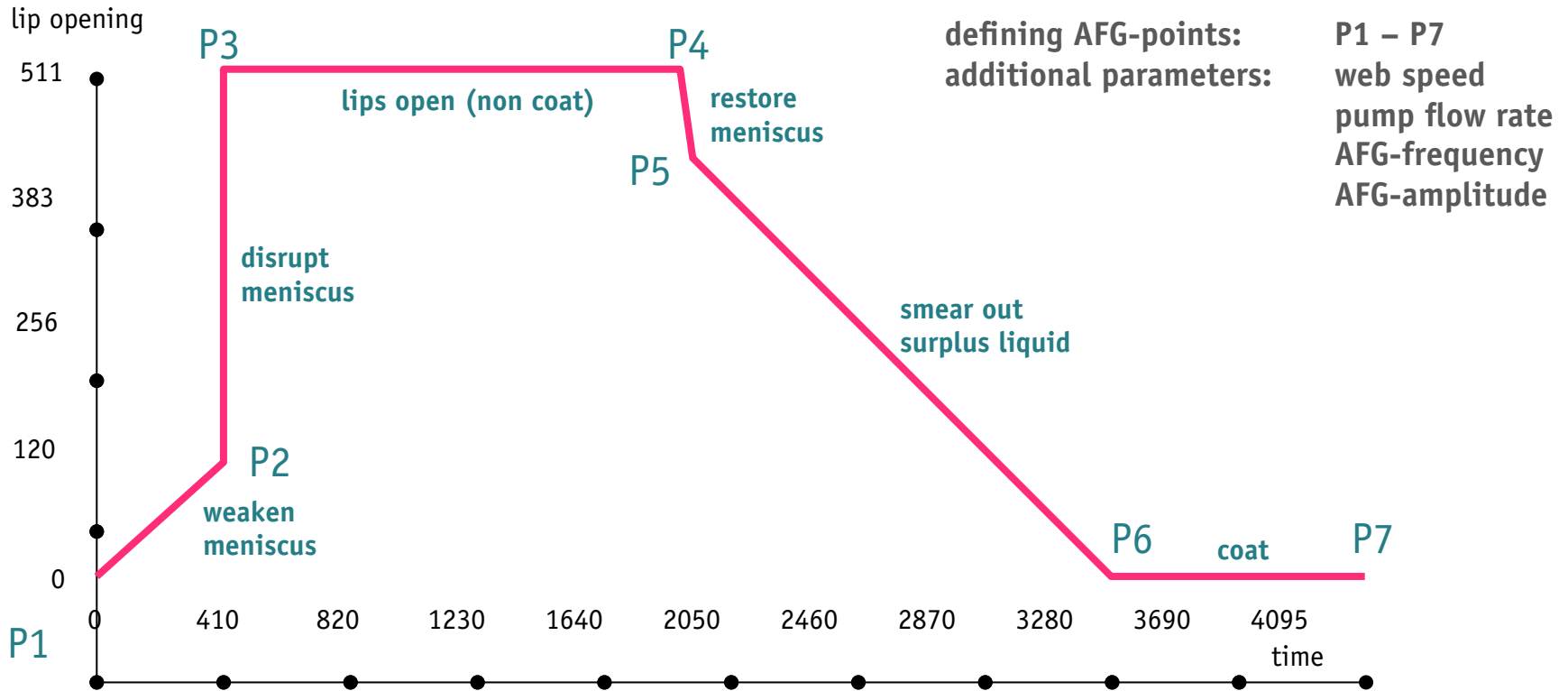
Structured coating – switching Slot Die: first results



Straight edges well defined
within 20 μm



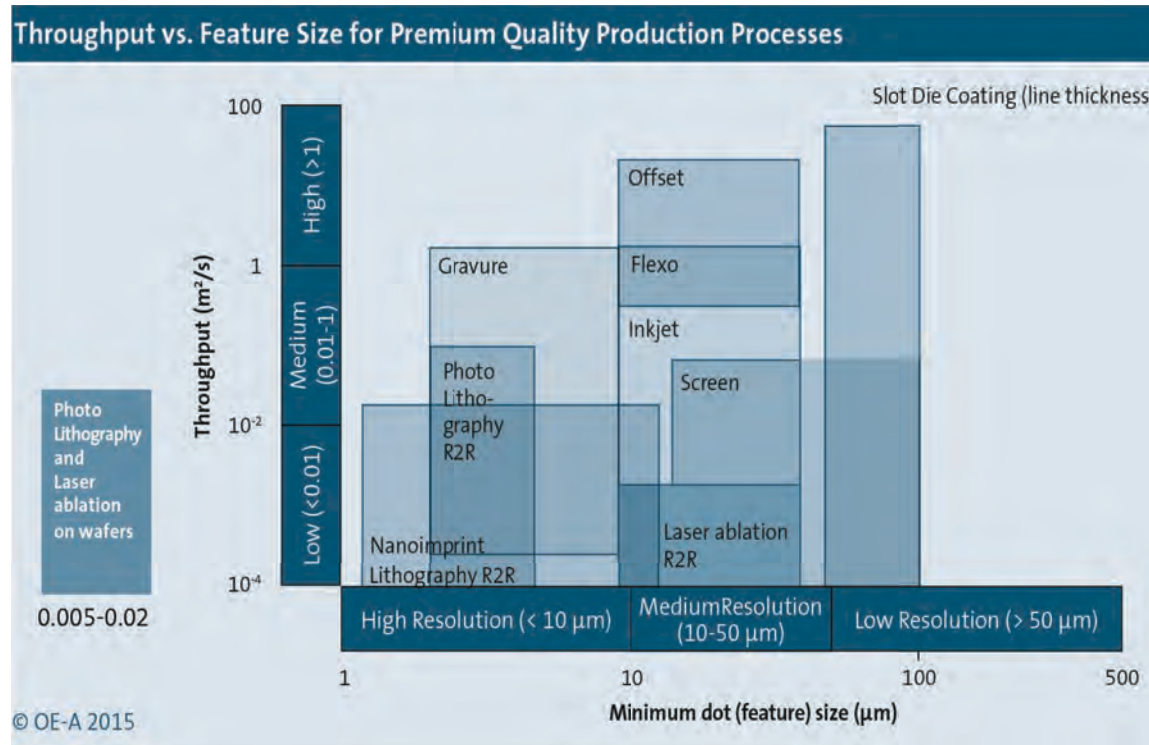
Structured coating – course of lip motion



Structured coating – actual trials: stripe coating of fuel cell paste



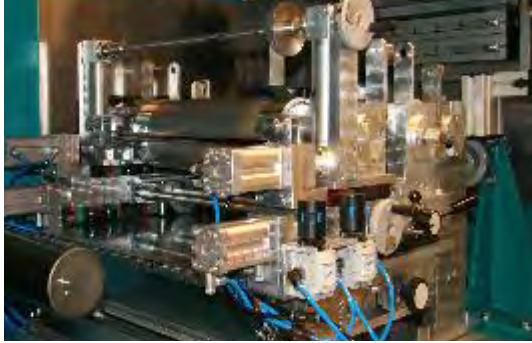
Printing Parameters



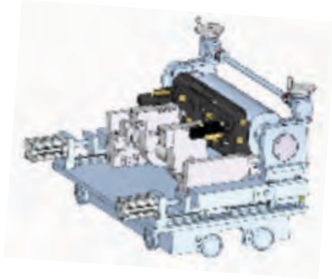
Printing Parameters

Printing method	Printing speed (m/s)	Nip pressure (MPa)	Ink viscosity (Pa · s)	Layer thickness (µm)	Feature size (µm)	Registration (µm)
Flexography	3 – 10	0,1 – 0,5	0,01 – 0,5	0,04 – 8	40 – 80	20 – 200
Gravure	10 – 16	1,5 – 5	0,01 – 0,2	0,1 – 12	20 – 75	>10
Offset	8 – 15	0,8 – 2	1 – 100	0,5 – 3	25 – 50	>10
Screen printing	2	–	0,1 – 50	3 – 100	75 – 100	>25
Inkjet	1 – 5	–	0,001 – 0,03	0,01 – 0,5 20 (UV)	10 – 50	<10

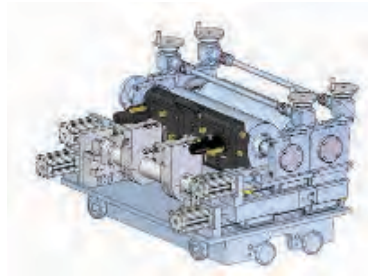
Printing Systems



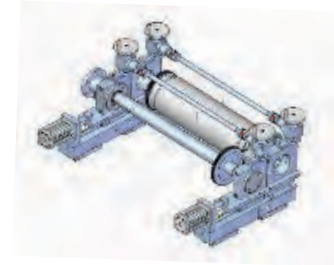
Gravure printing



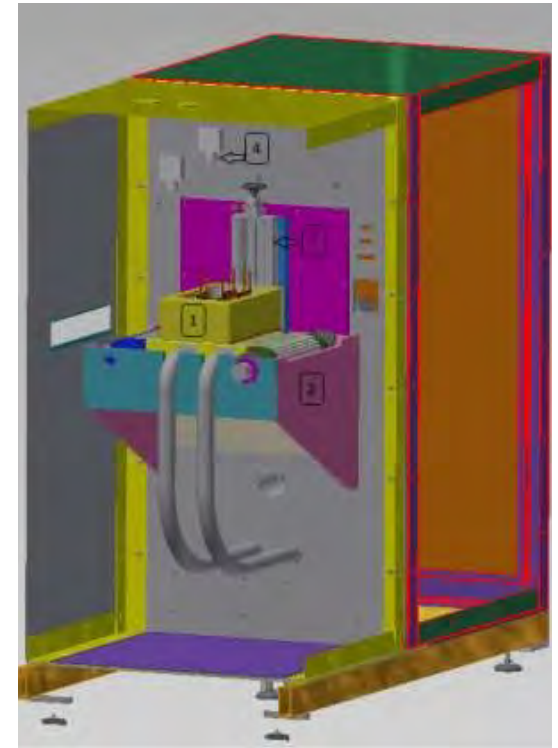
Flexo printing



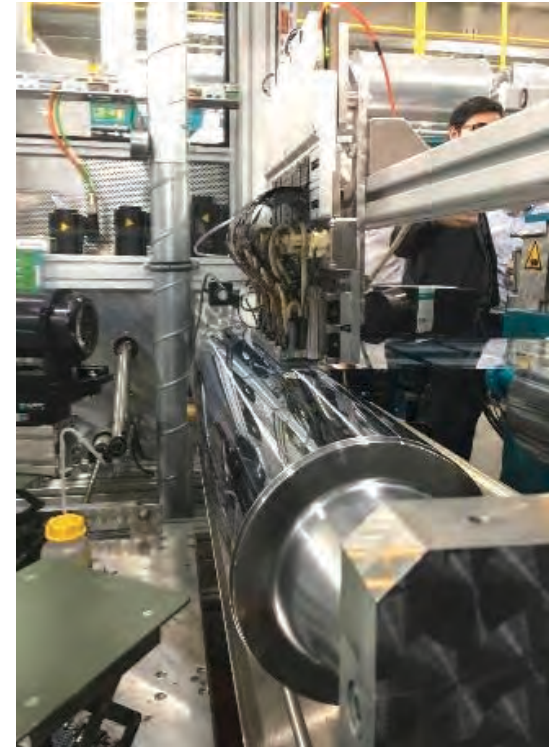
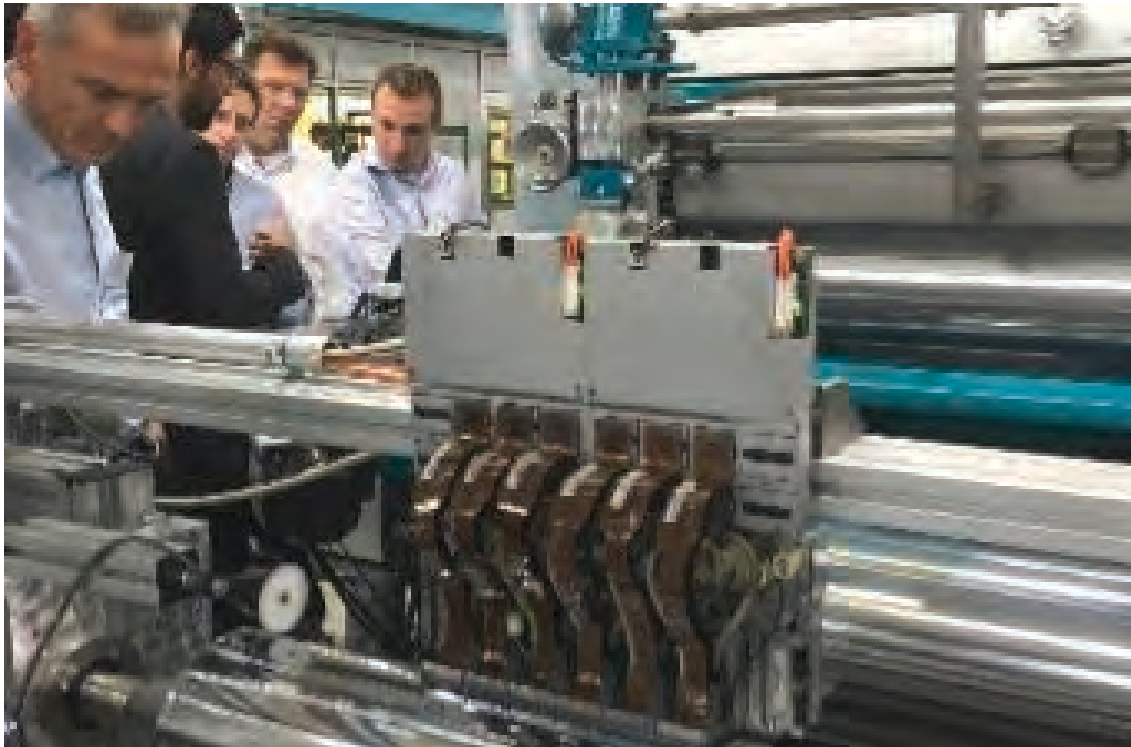
Screen printing



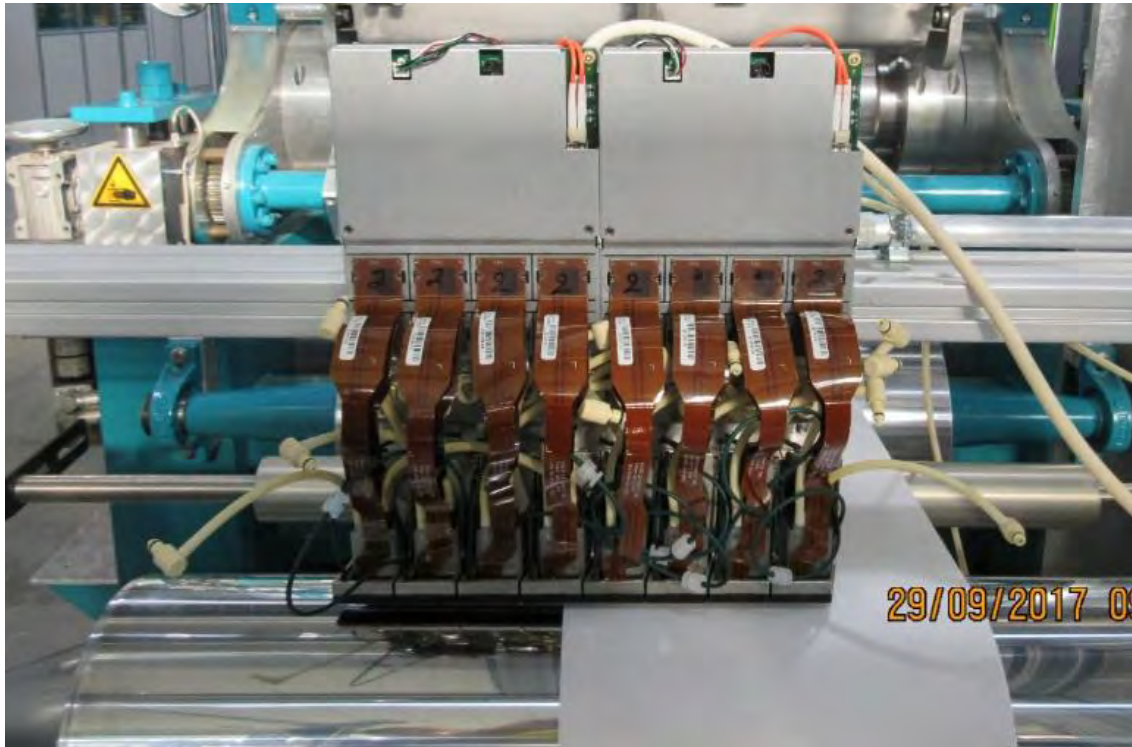
Inkjet Printing



Inkjet Printing



Integration of the „inking“ system – Current status



- ✓ Printing head and mounting (Fujifilm Dimatix Samba)
- ✓ Fluid recirculation system
- ✓ Power supply
- ✓ Computer

Integration of analysis and sintering units – Current status

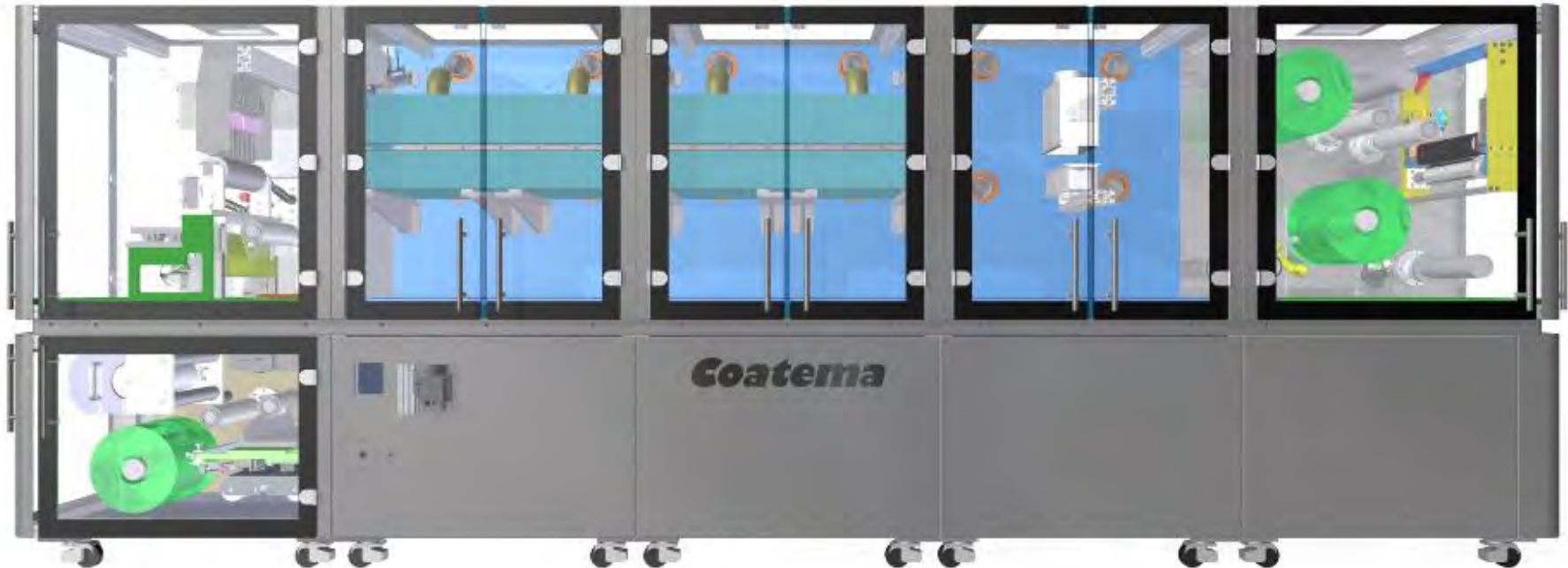


- ✓ Dantex dynamics
“dropwatching”
- ✓ Velocity
- ✓ Size
- ✓ Sphericity
- ✓ Drying / Sintering
- ✓ Adphos NIR
- ✓ IR lamp
- ✓ Photonic sintering
- ✓ Hot Air dryer

Integration – Current status

- ✓ Combination of print heads with high precision Granit stone
- ✓ Several sintering methods possible
 - ✓ Hot Air dryer to remove solvents (LEL)
 - ✓ NIR / IR / Photonic sintering for conductivity
- ✓ Droplet analysis
- ✓ Possibility to combine Inkjet with NIL

Integration – Machine layout



Integration – Machine layout



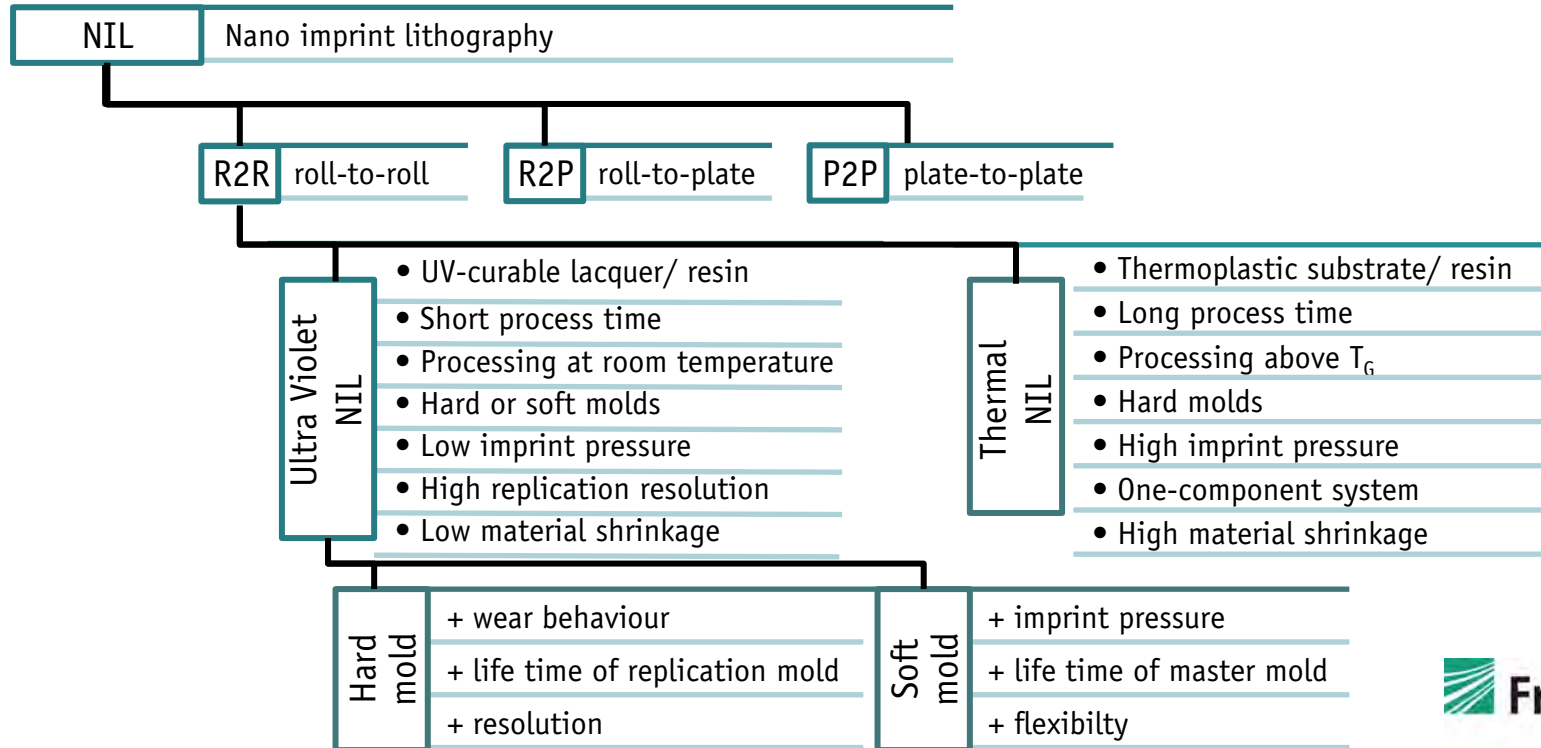
Summary

- ✓ Inkjet provides a step towards a more flexible and customizable production
- ✓ Inkjet is successfully integrated in a R2R process on 300 mm width
- ✓ Width is scalable
- ✓ Speeds up to 10 m/min were tested
- ✓ Different curing / drying systems were tested
- ✓ A layout for a Inkjet dedicated machine is available

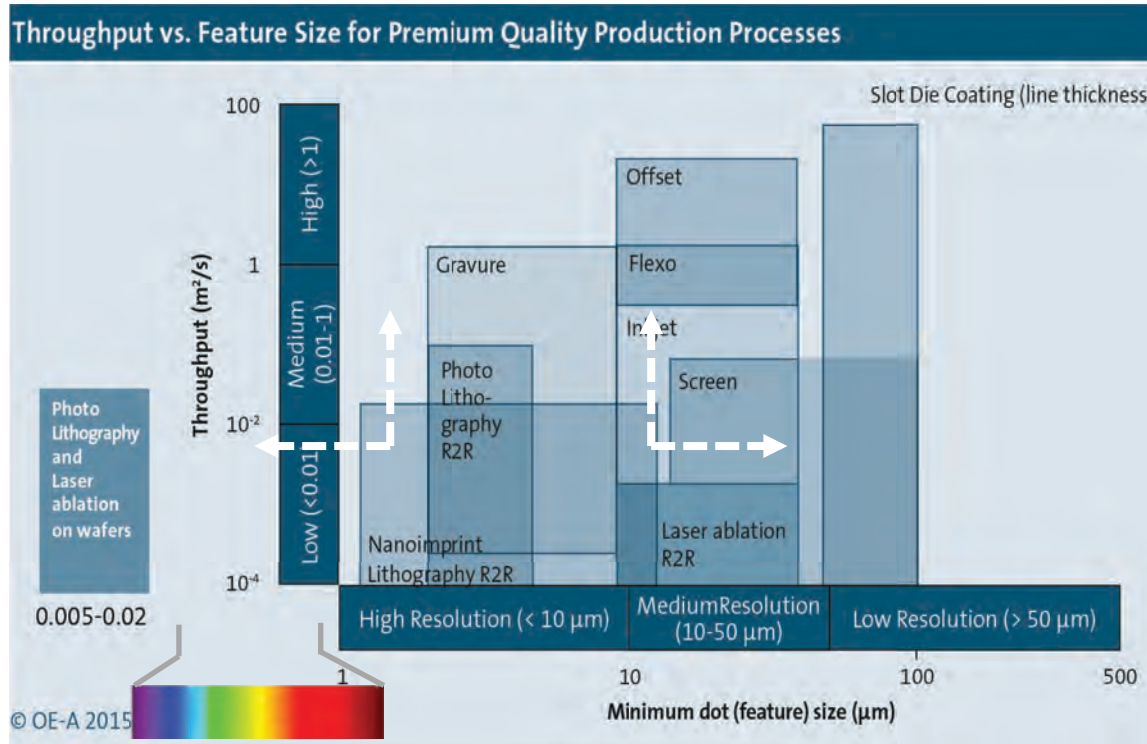
Nanoimprint technology



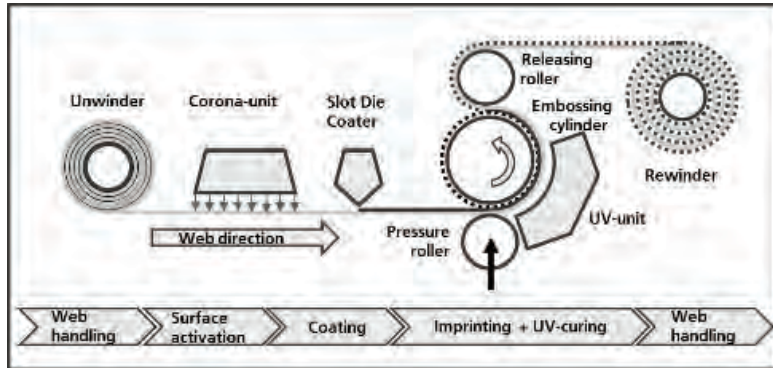
Nanoimprint technology



Introduction – Comparison of Printing Processes

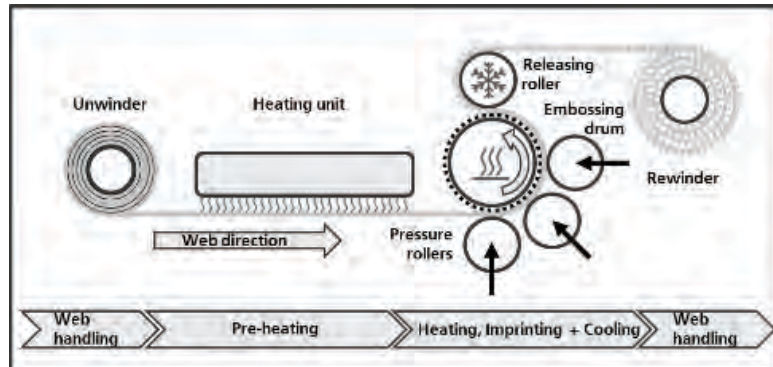


Nanoimprint Lithography



UV-NIL system designs:

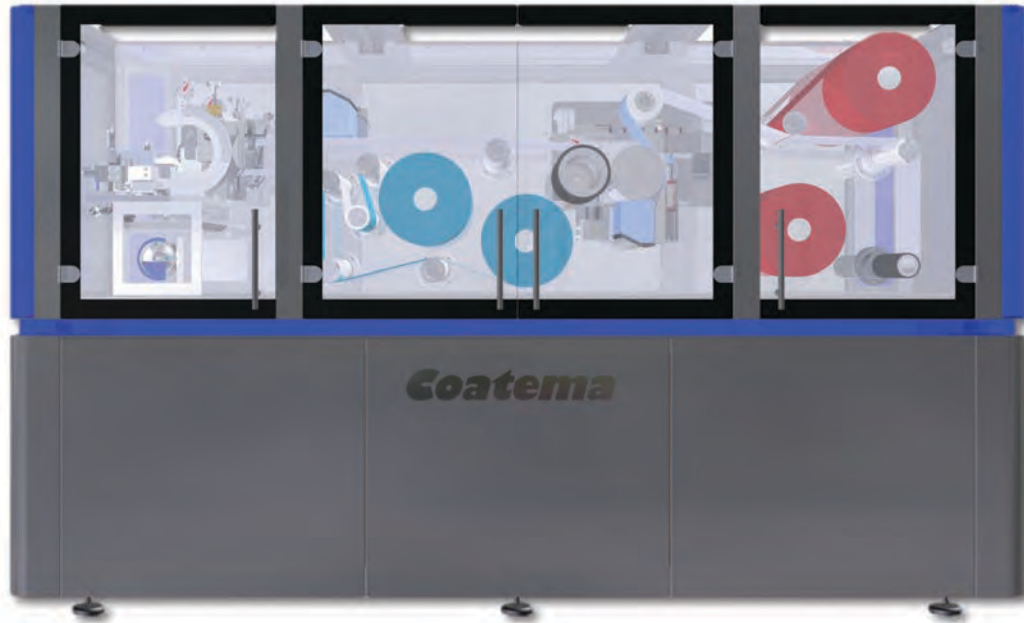
- ✓ Surface activation
Corona, plasma, chemical treatment
- ✓ Coating (Slot Die, Knife, Roller coater,...)
- ✓ UV curing (Mercury, LED UV radiator)



NIL system designs:

- ✓ Heating
IR / NIR, inductive, laser heating or heated fluids in embossing drum
- ✓ Replication mold
- ✓ Drum, endless belt, film
- ✓ One- / Multi-Temperature zones

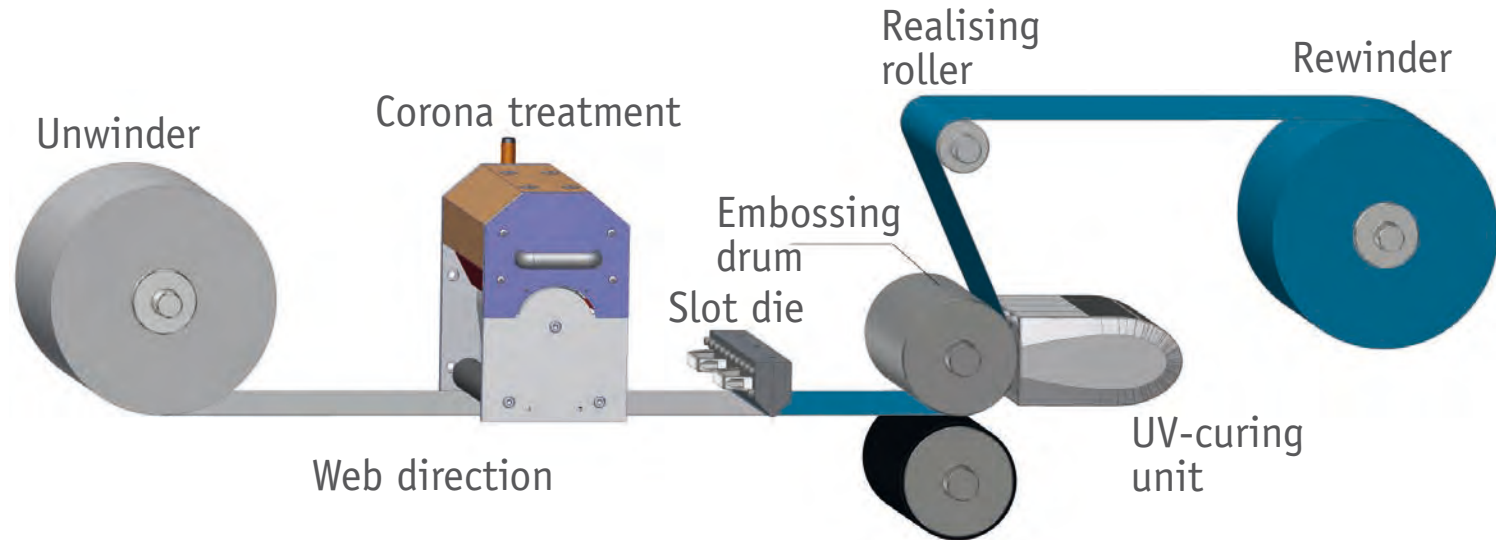
Nanoimprint Lithography



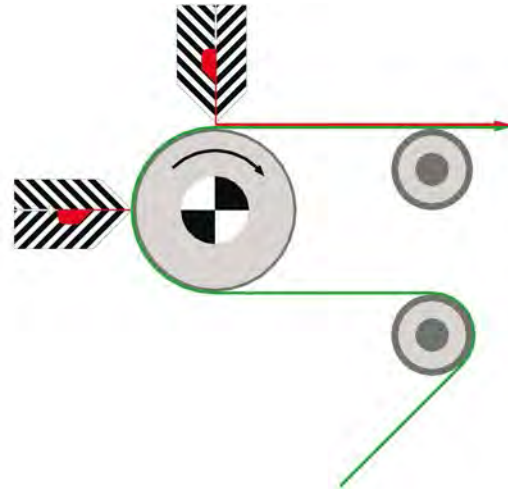
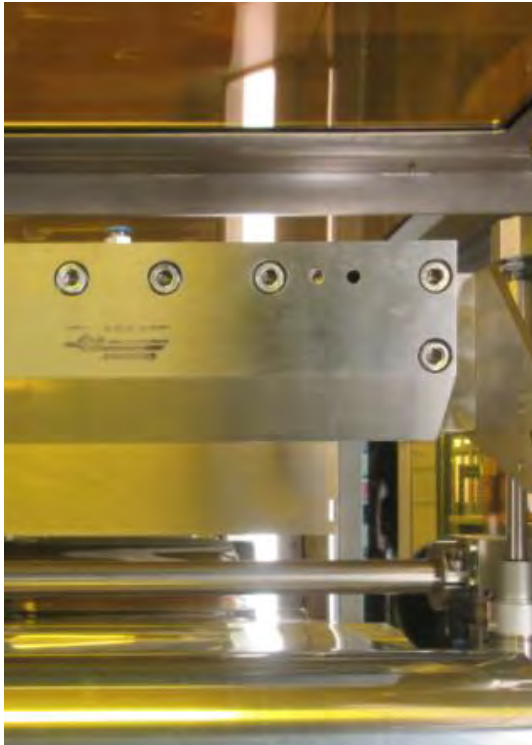
Process parameters (selection):

- ✓ Resist
 - ✓ Chem. Formulation
 - ✓ Viscosity / Rheology
- ✓ Film
 - ✓ Chem. Formulation
 - ✓ Chemical / mechanical pre-treatment
- ✓ Tool
 - ✓ Hard / soft mold
 - ✓ Anti-adhesion layer
- ✓ UV-source
 - ✓ Spectral distribution
 - ✓ LED- / conventional source
- ✓ Production system
 - ✓ Web (tension) control
 - ✓ Process specific sub-assemblies

Nanoimprint Lithography



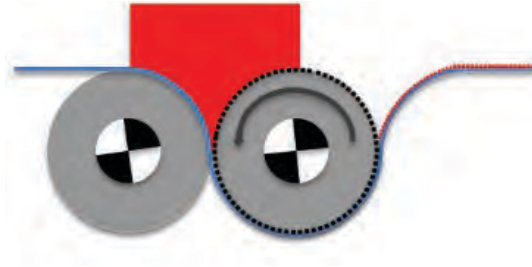
Coating and Printing for NIL – Nanoimprint Lithography



Slot Die coating for pre-metered film coating

- ✓ Layer control
- ✓ Level control in the nip
- ✓ 12/9" position
- ✓ Intermittent ink control

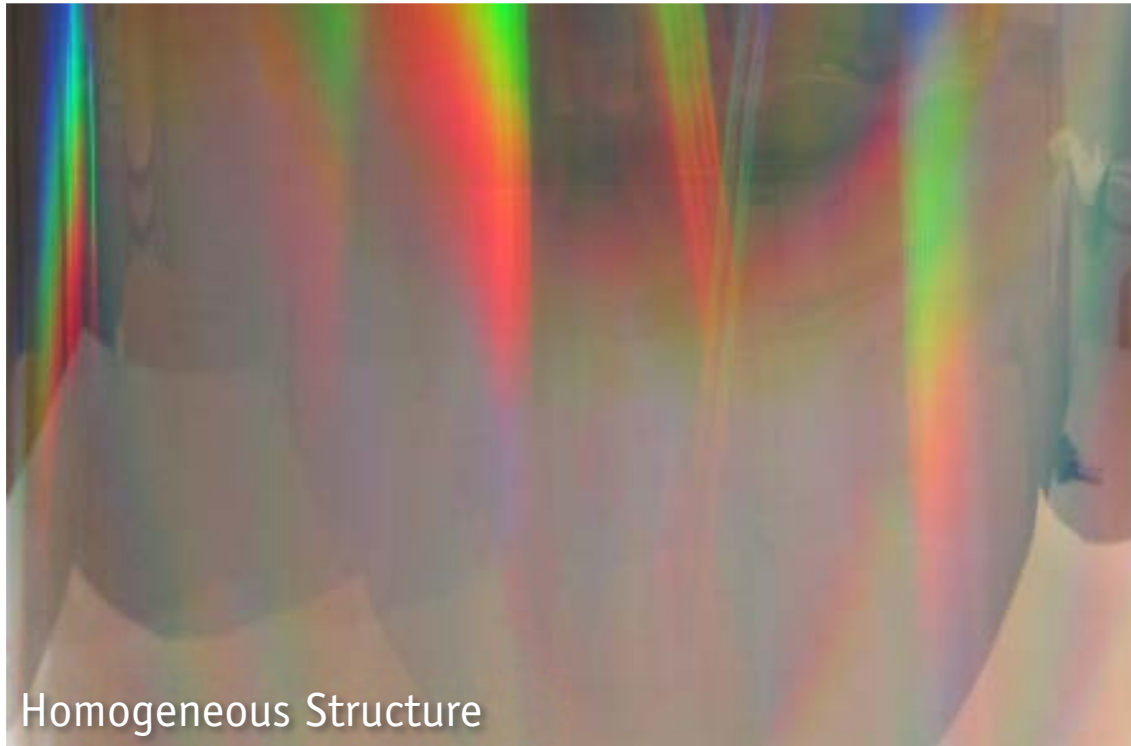
Coating and Printing for NIL – Nanoimprint Lithography



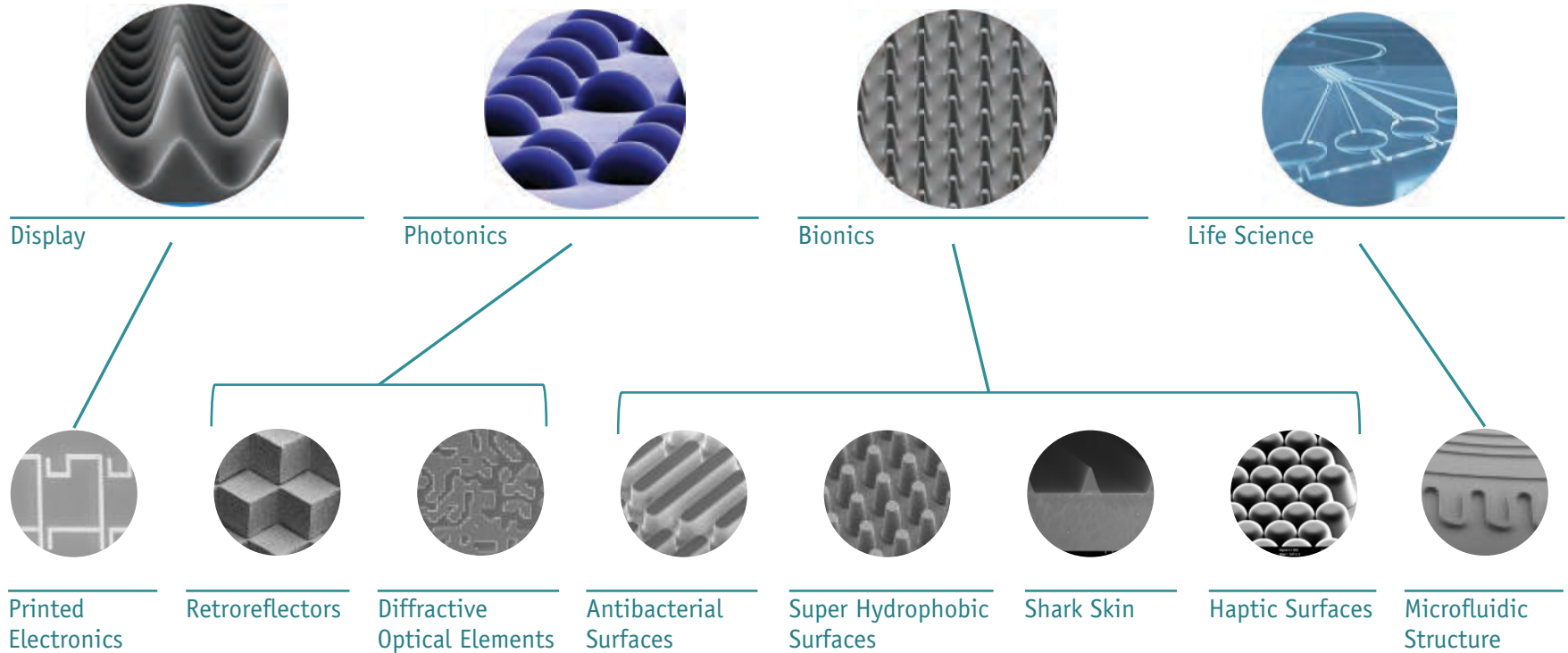
Nip coating

- ✓ Layer control by gap
- ✓ Level control in the nip
- ✓ Compact process

Coating and Printing for NIL – Nanoimprint Lithography



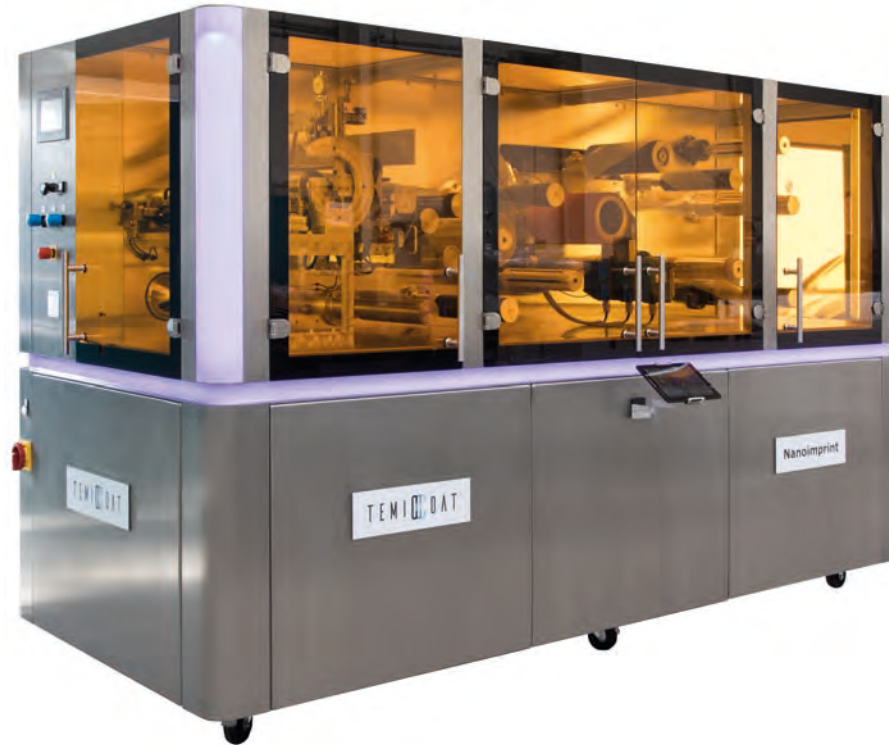
Applications



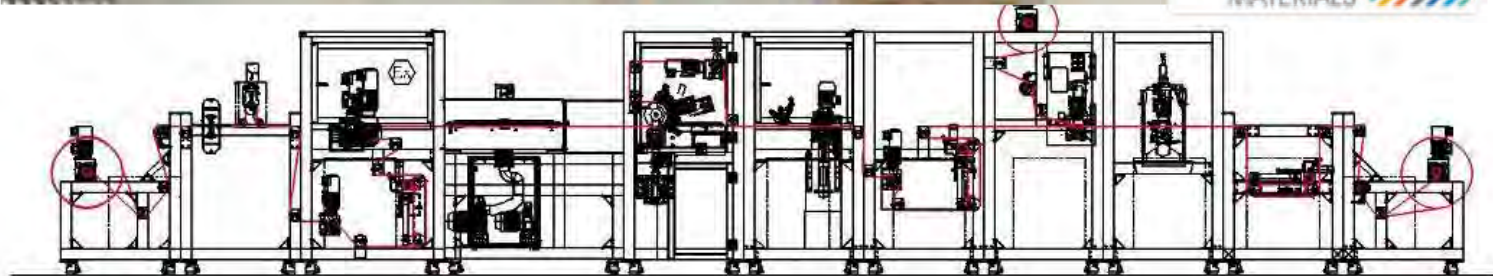
UV / NIL – Machines for Lab2Fab – R2R



UV / NIL – Machines for Lab2Fab – R2R



Nanoimprinting Combi System



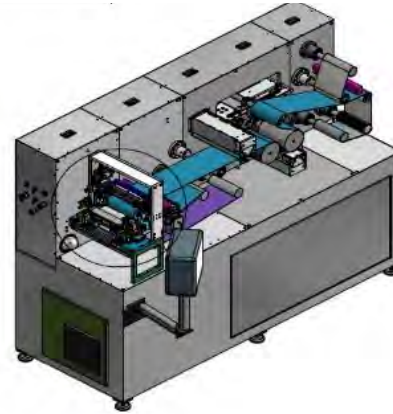
UV / NIL – Lab2Fab – R2R & R2P



Temicoat
Test Solution S2S



Temicoat
Test Solution R2R



Temicoat
NIL 300 R2R



Temicoat
NIL 300 R2P

Summary

Introduction

Equipment

Our markets

R&D

The printed
electronics
market

Bridging
the gap

Technologies
& Processes

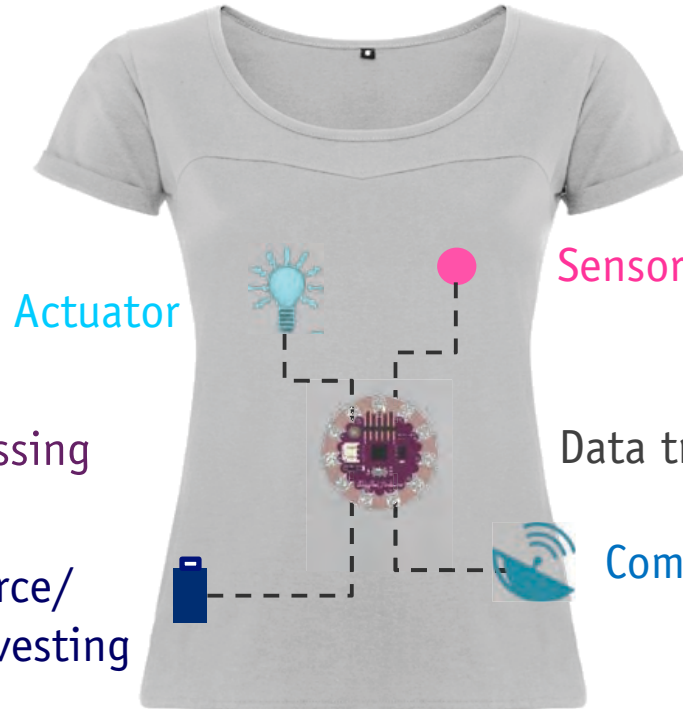
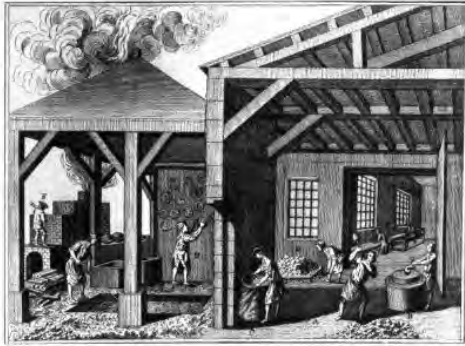
Summary

Bridging the gap

Needed for success:

- ✓ Reproducible results in every step of scale?
- ✓ Reality check if the approach is really scalable?
- ✓ Is the approach an approach for the real life production environment or is it rocket science?
- ✓ Are economies of scale reachable and when?
- ✓ Is durability really needed?
- ✓ Standardization of device manufacturing is the key for the industry
- ✓ Maybe small is the new big?

Bridging the gap



Thank you



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